COMPREHENSIVE SERVICES

We offer competitive repair and calibration services, as well as easily accessible documentation and free downloadable resources.

SELL YOUR SURPLUS

We buy new, used, decommissioned, and surplus parts from every NI series. We work out the best solution to suit your individual needs.

Sell For Cash Get Credit Receive a Trade-In Deal

OBSOLETE NI HARDWARE IN STOCK & READY TO SHIP

We stock New, New Surplus, Refurbished, and Reconditioned NI Hardware.



Bridging the gap between the manufacturer and your legacy test system.

0

1-800-915-6216



www.apexwaves.com

sales@apexwaves.com

All trademarks, brands, and brand names are the property of their respective owners.

Request a Quote



PCIe-6612

DAQ

NI 660*X* Register-Level Programmer Manual



Worldwide Technical Support and Product Information

ni.com

National Instruments Corporate Headquarters

11500 North Mopac Expressway Austin, Texas 78759-3504 USA Tel: 512 683 0100

Worldwide Offices

Australia 03 9879 5166, Austria 0662 45 79 90 0, Belgium 02 757 00 20, Brazil 55 11 3262 3599, Canada (Calgary) 403 274 9391, Canada (Montreal) 514 288 5722, Canada (Ottawa) 613 233 5949, Canada (Québec) 514 694 8521, Canada (Toronto) 905 785 0085, China 86 21 6555 7838, Czech Republic 02 2423 5774, Denmark 45 76 26 00, Finland 09 725 725 11, France 01 48 14 24 24, Germany 089 741 31 30, Greece 01 42 96 427, Hong Kong 2645 3186, India 91 80 4190000, Israel 03 6393737, Italy 02 413091, Japan 03 5472 2970, Korea 02 3451 3400, Malaysia 603 9596711, Mexico 001 800 010 0793, Netherlands 0348 433466, New Zealand 09 914 0488, Norway 32 27 73 00, Poland 22 3390 150, Portugal 210 311 210, Russia 095 238 7139, Singapore 65 6 226 5886, Slovenia 3 425 4200, South Africa 11 805 8197, Spain 91 640 0085, Sweden 08 587 895 00, Switzerland 056 200 51 51, Taiwan 02 2528 7227, United Kingdom 01635 523545

For further support information, see the *Technical Support and Professional Services* appendix. To comment on the documentation, send email to techpubs@ni.com.

© 2002 National Instruments Corporation. All rights reserved.

Important Information

Warranty

The NI PCI-6601, NI PCI-6602, NI PXI-6602, and NI PXI-6608 devices are warranted against defects in materials and workmanship for a period of one year from the date of shipment, as evidenced by receipts or other documentation. National Instruments will, at its option, repair or replace equipment that proves to be defective during the warranty period. This warranty includes parts and labor.

The media on which you receive National Instruments software are warranted not to fail to execute programming instructions, due to defects in materials and workmanship, for a period of 90 days from date of shipment, as evidenced by receipts or other documentation. National Instruments will, at its option, repair or replace software media that do not execute programming instructions if National Instruments receives notice of such defects during the warranty period. National Instruments does not warrant that the operation of the software shall be uninterrupted or error free.

A Return Material Authorization (RMA) number must be obtained from the factory and clearly marked on the outside of the package before any equipment will be accepted for warranty work. National Instruments will pay the shipping costs of returning to the owner parts which are covered by warranty.

National Instruments believes that the information in this document is accurate. The document has been carefully reviewed for technical accuracy. In the event that technical or typographical errors exist, National Instruments reserves the right to make changes to subsequent editions of this document without prior notice to holders of this edition. The reader should consult National Instruments if errors are suspected. In no event shall National Instruments be liable for any damages arising out of or related to this document or the information contained in it.

Except as specified herein, National Instruments makes no warranties, express or implied, and specifically disclaims any warranty of merchantability or fitness for a particular purpose. Customer's right to recover damages caused by fault or negligence on the part of National Instruments shall be limited to the amount therefore paid by the customer. National Instruments will not be liable for Damages resulting from loss of data, profits, use of products, or incidental or consequential damages, even if advised of the possibility thereof. This limitation of the liability of National Instruments will apply regardless of the form of action, whether in contract or tort, including negligence. Any action against National Instruments must be brought within one year after the cause of action accrues. National Instruments shall not be liable for any delay in performance due to causes beyond its reasonable control. The warranty provided herein does not cover damages, defects, malfunctions, or service failures caused by owner's failure to follow the National Instruments installation, operation, or maintenance instructions; owner's modification of the product; owner's abuse, misuse, or negligent acts; and power failure or surges, fire, flood, accident, actions of third parties, or other events outside reasonable control.

Copyright

Under the copyright laws, this publication may not be reproduced or transmitted in any form, electronic or mechanical, including photocopying, recording, storing in an information retrieval system, or translating, in whole or in part, without the prior written consent of National Instruments Corporation.

Trademarks

 CVI^{IM} , $\text{DAQCard}^{\text{IM}}$, $\text{DAQ-STC}^{\text{IM}}$, $\text{LabVIEW}^{\text{IM}}$, $\text{Measurement Studio}^{\text{IM}}$, MITE^{IM} , MXI^{IM} , $\text{National Instruments}^{\text{IM}}$, NI^{IM} , $\text{ni.com}^{\text{IM}}$, $\text{NI-DAQ}^{\text{IM}}$, and RTSI^{IM} are trademarks of National Instruments Corporation.

Product and company names mentioned herein are trademarks or trade names of their respective companies.

Patents

For patents covering National Instruments products, refer to the appropriate location: **Help»Patents** in your software, the patents.txt file on your CD, or ni.com/patents.

WARNING REGARDING MEDICAL AND CLINICAL USE OF NATIONAL INSTRUMENTS PRODUCTS

(1) NATIONAL INSTRUMENTS PRODUCTS ARE NOT DESIGNED WITH COMPONENTS AND TESTING FOR A LEVEL OF RELIABILITY SUITABLE FOR USE IN OR IN CONNECTION WITH SURGICAL IMPLANTS OR AS CRITICAL COMPONENTS IN ANY LIFE SUPPORT SYSTEMS WHOSE FAILURE TO PERFORM CAN REASONABLY BE EXPECTED TO CAUSE SIGNIFICANT INJURY TO A HUMAN.

(2) IN ANY APPLICATION, INCLUDING THE ABOVE, RELIABILITY OF OPERATION OF THE SOFTWARE PRODUCTS CAN BE IMPAIRED BY ADVERSE FACTORS, INCLUDING BUT NOT LIMITED TO FLUCTUATIONS IN ELECTRICAL POWER SUPPLY, COMPUTER HARDWARE MALFUNCTIONS, COMPUTER OPERATING SYSTEM SOFTWARE FITNESS, FITNESS OF COMPILERS AND DEVELOPMENT SOFTWARE USED TO DEVELOP AN APPLICATION, INSTALLATION ERRORS, SOFTWARE AND HARDWARE COMPATIBILITY PROBLEMS, MALFUNCTIONS OR FAILURES OF ELECTRONIC MONITORING OR CONTROL DEVICES, TRANSIENT FAILURES OF ELECTRONIC SYSTEMS (HARDWARE AND/OR SOFTWARE), UNANTICIPATED USES OR MISUSES, OR ERRORS ON THE PART OF THE USER OR APPLICATIONS DESIGNER (ADVERSE FACTORS SUCH AS THESE ARE HEREAFTER COLLECTIVELY TERMED "SYSTEM FAILURES"). ANY APPLICATION WHERE A SYSTEM FAILURE WOULD CREATE A RISK OF HARM TO PROPERTY OR PERSONS (INCLUDING THE RISK OF BODILLY INJURY AND DEATH). SHOULD NOT BE RELIANT SOLELY UPON ONE FORM OF ELECTRONIC SYSTEM DUE TO THE RISK OF SYSTEM FAILURE. TO AVOID DAMAGE, INJURY, OR DEATH, THE USER OR APPLICATION DESIGNER MUST TAKE REASONABLY PRUDENT STEPS TO PROTECT AGAINST SYSTEM FAILURES, INCLUDING BUT NOT LIMITED TO BACK-UP OR SHUT DOWN MECHANISMS. BECAUSE EACH END-USER SYSTEM IS CUSTOMIZED AND DIFFERS FROM NATIONAL INSTRUMENTS' TESTING PLATFORMS AND BECAUSE A USER OR APPLICATION DESIGNER MAY USE NATIONAL INSTRUMENTS PRODUCTS IN COMBINATION WITH OTHER PRODUCTS IN A MANNER NOT EVALUATED OR CONTEMPLATED BY NATIONAL INSTRUMENTS, THE USER OR APPLICATION DESIGNER IS ULTIMATELY RESPONSIBLE FOR VERIFYING AND VALIDATING THE SUITABILITY OF NATIONAL INSTRUMENTS PRODUCTS WHENEVER NATIONAL INSTRUMENTS PRODUCTS ARE INCORPORATED IN A SYSTEM OR APPLICATION, INCLUDING, WITHOUT LIMITATION, THE APPROPRIATE DESIGN, PROCESS AND SAFETY LEVEL OF SUCH SYSTEM OR APPLICATION.

Contents

Abo	out This Manual	
	Using the Manual Set	ix
	Conventions	
	Related Documentation	
Cha	apter 1	
	out the NI 660 <i>X</i> Devices	
	Structural Overview	1-2
	MITE PCI Interface ASIC	1-2
	NI-TIO General-Purpose Counter/Timer ASIC	
	NI-TIO GPCTs	
	Features	1-3
	Simplified Model	
	Pulse Generation	1-5
	Measurement	1-6
	Oscillator	1-6
	EEPROM	1-7
	Real-Time System Integration (RTSI)	1-7
	Other Features	1-7
	Using PXI with CompactPCI	1-7
~ !		
una	apter 2	
Pro	gramming General-Purpose Counter/Timers	
	PCI Local Bus	2-1
	PCI Initialization for the IBM Compatible System	
	Remapping the NI 660X Device	
	Functional Overview.	
	Reading Counter Values	
	Disarmed Counters	
	Armed Counters	
	Buffered Readings	
	Counter/Timer Functions and Examples	
	Event Counting	
	Simple Event Counting	
	Simple Gated-Event Counting	
	Buffered Cumulative Event Counting	
	Buffered Noncumulative Event Counting	
	Zantita i tantamami ta Brent Commis	

	Position Measurement	2-9
	Relative Position Measurement	2-9
	Time Measurement	2-10
	Single-Period Measurement	2-10
	Single Pulse Width Measurement	
	Buffered Period Measurement	2-12
	Buffered Pulse Width Measurement	2-13
	Pulse Generation	
	Single Pulse Generation	
	Pulse-Train Generation	
	Continuous Pulse-Train Generation	2-15
	Single Triggered Pulse Generation	2-16
Chapter 3		
Register M	•	
NI-TIC)	
	Register Map and Descriptions	
	Chip Signature Register	
	Clock Config Register	
	DMA Configuration Register	
	G0 Interrupt Enable Register, G2 Interrupt Enable Register	
	G01 Joint Reset Register, G23 Joint Reset Register	
	G01 Joint Status 1 Register	
	G01 Status Register, G23 Status Register	
	G1 Interrupt Enable Register, G3 Interrupt Enable Register	
	G23 Joint Status 1 Register	
	Gi Autoincrement Register	
	Gi Command Register	
	Gi Counting Mode Register	
	Gi DMA Config Register	
	Gi DMA Status Register	
	Gi Input Select Register	
	G0 Interrupt Acknowledge Register, G2 Interrupt	2 - /
	Acknowledge Register	3-30
	G1 Interrupt Acknowledge Register, G3 Interrupt	
	Acknowledge Register	3-31
	Gi Load A Register	
	Gi Load B Register	
	Gi Mode Register	
	Gi Second Gate Register	
	Gi Status Register	
	Gi SW Save Register	

Global Interrupt Config Register	3-41
Global Interrupt Status Register	
Reset Control Register	
Simple Digital I/O	
STC Digital I/O	
STC Digital I/O Registers	
STC DIO Control	
STC DIO Output	
STC DIO Parallel Input	
STC DIO Serial Input	
I/O Connection Registers	
Pin Usage	
I/O Registers	
I/O Config Register, Pins A through B	
MITE	
I/O Window Base Size Register 1 (IOWBSR1)	
I/O Window Control Register 1 (IOWCR1)	

Appendix A Technical Support and Professional Services

Glossary

About This Manual

The *NI 660X Register-Level Programmer Manual* describes the programmable features of the National Instruments 660*X* devices. This document is necessary for programmers who use platforms not supported by NI-DAQ.

This manual contains information necessary for the register-level programming of NI 660*X* devices. This manual includes the following information:

- Address and function registers for reading and writing data, and for configuring the input lines and the general-purpose counter/timers (GPCTs)
- Overview of several common GPCT operations
- Guidelines for configuring GPCTs



Note Use the change notification feature *only* if you are familiar with writing, installing, and uninstalling interrupt service routines (ISRs).

NI recommends programming the NI 660X device using NI-DAQ with application development environment software, such as LabVIEW, LabWindows™/CVI™, or Measurement Studio. Application software provides easier programming with the same flexibility as register-level programming and much faster development time.

Using the Manual Set

The NI 660X Register-Level Programmer Manual is one piece of the documentation set for the data acquisition (DAQ) system. For information about a specific NI 660X device, refer to the documentation for that device. The user manual provides installation procedures, connection requirements, programming options, specifications, and guidelines for operating the NI 660X devices.

Consult the accessory installation guides or manuals for information about accessory products. The terminal block and cable assembly installation guides or accessory user manuals explain how to connect system parts.

Conventions

This manual	uses	the	following	conventions:
I III 5 III ali aa	. ubcb	uic	TOHOWING	conventions.

Angle brackets that contain numbers separated by an ellipsis represent

a range of values associated with a bit or signal name—for example,

DI0<3..0>.

» The » symbol leads you through nested menu items and dialog box options

to a final action. The sequence **File»Page Setup»Options** directs you to pull down the **File** menu, select the **Page Setup** item, and select **Options**

from the last dialog box.

This icon denotes a note, which alerts you to important information.

This icon denotes a caution, which advises you of precautions to take to

avoid injury, data loss, or a system crash.

bold Bold text denotes items that you must select or click in the software, such

as menu items and dialog box options. Bold text also denotes parameter

names.

CompactPCI CompactPCI refers to the core specification defined by the PCI Industrial

Computer Manufacturer's Group (PICMG).

italic Italic text denotes variables, emphasis, a cross reference, or an introduction

to a key concept. This font also denotes text that is a placeholder for a word

or value that you must supply.

monospace Text in this font denotes sections of code, programming examples, and

syntax examples. This font is also used for the proper names of programs, subprograms, subroutines, device names, functions, operations, variables,

filenames and extensions, and code excerpts.

NI 660X This phrase refers to all devices in the NI 660X family, including the

NI PCI-6601 (NI 6601), NI PCI/PXI-6602 (NI 6602), and the NI PXI-6608

(NI 6608).

PCI Peripheral Component Interconnect—PCI is a high-performance

expansion bus architecture originally developed by Intel to replace ISA and

EISA.

PXI A rugged, open system for modular instrumentation based on CompactPCI,

with special mechanical, electrical, and software features.

Related Documentation

The following documents contain information that you might find helpful as you read this manual:

- 6601/6602 User Manual, available at ni.com/manuals
- Note to Users: About Your 6608 Device, available at ni.com/manuals
- PCI Local Bus Specification Rev 2.1, available from www.pcisig.com
- PICMG 2.0 R3.0, CompactPCI Specification, available at www.picmg.org
- *PXI Specification*, Revision 1.0, available at www.pxisa.org

About the NI 660X Devices

This chapter provides a summary of the NI 660*X* devices and includes a brief overview of the MXI Interface to Everything (MITE) and NI-TIO components.

The NI 660X devices are digital I/O (DIO) and timing I/O (TIO) devices for the PCI bus in PC-compatible computers and PXI or CompactPCI chassis.

The NI 6601 features four 32-bit counter channels and eight lines of individually configurable, TTL/CMOS-compatible DIO. The NI 6602 and NI 6608 have the same capabilities as the NI 6601, but feature eight 32-bit counter channels and an 80 MHz clock. The NI 6608 features an oven-controlled crystal oscillator (OCXO) for greater timing accuracy.

Refer to the 6601/6602 User Manual or the Note to Users: About Your 6608 Device for more information about device functionality, installation, connections, and safety guidelines.



Cautions Using the NI 660X devices in a way inconsistent with the 6601/6602 User Manual and the Note to Users: About Your 6608 Device can cause injury or equipment damage. NI is not liable for damage or injury resulting from incorrect use.

Incorrectly programming NI 660*X* devices can cause permanent damage to the devices. For example, some I/O pins can be driven from several outputs. Two sources driving the same I/O pin could burn out the I/O pin and destroy one of the ASICs. Because the NI 6602 and NI 6608 have two NI-TIO application-specific integrated circuits (ASICs), they are particularly subject to this kind of damage. If using both ASICs, configure the second NI-TIO to use the I/O pins for the second NI-TIO. Doing so prevents both NI-TIOs from connecting to the same I/O pins.

Structural Overview

The following functional groups make up the NI 660X circuitry:

- MITE PCI interface ASIC
- NI-TIO (0) GPCT ASIC
- NI-TIO (1) GPCT ASIC, available only on the NI 6602 and NI 6608

Figure 1-1 illustrates the data flow of the NI 660X devices.

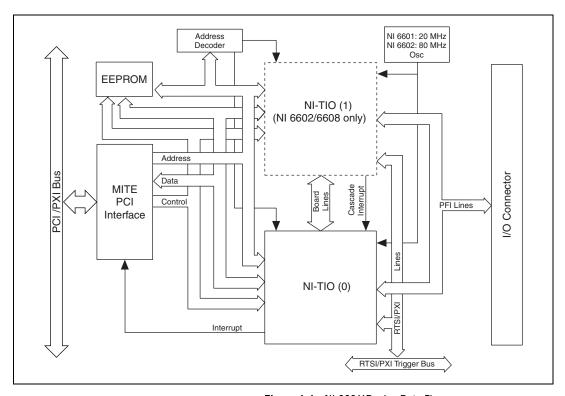


Figure 1-1. NI 660X Device Data Flow

MITE PCI Interface ASIC

The MITE is the interface for register accesses, interrupts, and direct memory access (DMA). The MITE enables communication between the NI 660X device and the PCI or PXI bus. Once initialized, the MITE enables communication with other NI 660X components.

NI-TIO General-Purpose Counter/Timer ASIC

Each NI-TIO contains four independent general-purpose counters. Each counter has a source, two gates, an output, and multiple load registers. The NI 6601 has one NI-TIO—NI-TIO (0)—and the NI 6602 and NI 6608 each have two NI-TIOs—NI-TIO (0) and NI-TIO (1).



Caution To avoid double-driving the counter outputs on the NI 6602 and NI 6608, set the Counter_Swap bit in the *Clock Config Register* to configure the second NI-TIO to use counters 4 through 7. If incorrectly configured, both NI-TIOs can use the I/O connectors for counters 0 through 3, which could permanently damage the device.

NI-TIO GPCTs

Each NI-TIO consists of four independent 32-bit up/down counters. These counters are identical, except for the internal routing of the counter inputs and outputs. Each counter has associated load and save registers and a control structure for implementing some common counting and TIO functions. The timing functions include period measurement, pulse width measurement, event counting, single-pulse generation, and pulse-train generation with programmable frequency and duty cycle.



Note Most functions can operate using only one general-purpose counter.

Measurement functions have two operational modes: single mode and buffered mode. Single-mode functions obtain only one measurement, and buffered mode functions obtain a series of consecutive, gap-free measurements.

You can select GPCT input signals from the external TIO pins on the NI 660X devices. Available input options depend on the GPCT input type. Output generation and timing measurement are the two primary GPCT modes.

Features

The NI-TIO has the following features:

- Four independent 32-bit binary up/down counters
- Count-up/count-down control through hardware or software
- Programmable counter source and gate selection from 19 signal sources
- Programmable input and output signal polarities
- Single-pulse or continuous pulse generation output

- Inter-event (relative) timestamping
- Two sets of save registers so that you can save the counter value through an external control signal or through software command
- Current count value readings that do not affect circuit operation
- Interrupts based on terminal count (TC)—rising edge, falling edge, or any edge
- Quadrature encoder position measurements



Note The NI 660X devices do *not* support binary-coded decimal (BCD) counting and time-of-day counting.

Simplified Model

Each GPCT contains four identical 32-bit binary up/down counters. Figure 1-2 shows a simplified model of the GPCT.

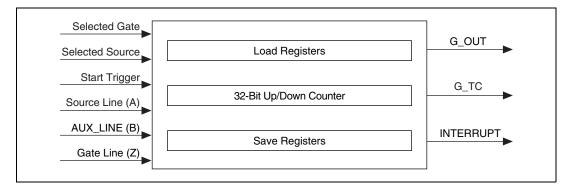


Figure 1-2. General-Purpose Counter/Timer Simplified Model

Each GPCT has a source input (Selected Source), a gate input (Selected Gate), and a second gate input (AUX_LINE) that doubles as an up/down control input. When the counter is enabled, rising edges on the Selected Source input cause the counter to increment or decrement. The Selected Gate input acts as a general-purpose control signal and can operate as a counter trigger signal, a counter enable, a save signal, a reload signal, an interrupt, an output control signal, a load register select signal, or a counter disarm.

The counter outputs are the signals labeled G_OUT and INTERRUPT. G_OUT is a TC-related counter output signal that can toggle on every counter TC or directly output the counter TC signal. INTERRUPT is a

counter output interrupt signal routed to the MITE. The load registers reload the counter with new count values, and the save registers save the counter contents until the software can read them.

Pulse Generation

In pulse generation mode, the counter decrements until reaching terminal count, the output of the counter changes, and a load register reloads the counter. The source may be a known frequency, in which case both the duty cycle and the output frequency are known. The source can also be an input that must be divided by an integer. The operation can be single-shot, repetitive, or triggered from the gate signal.

The NI-TIO has four available load registers—Load A and Load B in two X and Y bank cells. With this flexibility, you can generate any duty cycle and reprogram the load registers to change the properties on the fly. The output is typically programmed to alternate on each terminal count, but it can be programmed to toggle on the terminal count signal to create the smallest pulse or highest frequency output.

Figure 1-3 illustrates the pulse generation data flow.

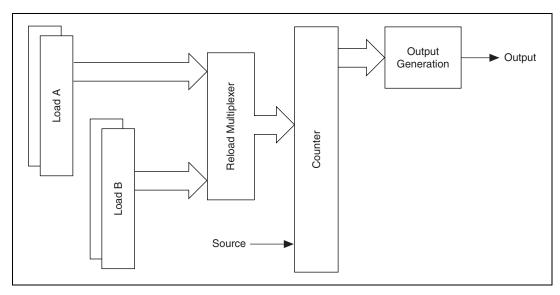


Figure 1-3. NI-TIO Pulse Generation Data Flow

Measurement

In measurement modes, the counter measures the source or the gate properties. Source edges increment or decrement the counter, and the gate signal stops and starts the counter. During buffered acquisitions, the gate signal also latches the counter state for either a software or DMA reading of the measurement. For measurements such as period, semiperiod, or pulse width, the counter uses a known timebase (usually the fastest internal timebase) for clocking, and the gate signal starts and stops the counter while latching the measurement. With event counting and frequency measurements, an unknown signal applied to the source and the gate is of a fixed time to create a window of measurement.

Figure 1-4 illustrates the measurement data flow.

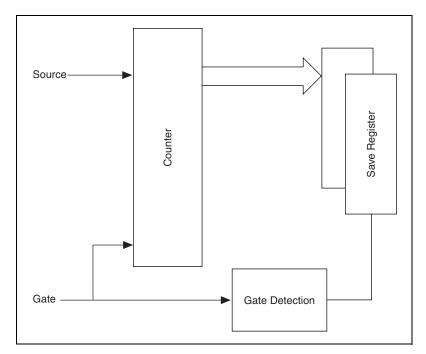


Figure 1-4. Measurement Data Flow

Oscillator

The signal from the oscillator is the internal timebase for the NI 660X devices. The NI 6601 uses a 20 MHz oscillator, and the NI 6602 and NI 6608 each use a 80 MHz oscillator.

EEPROM

The EEPROM stores PCI Plug and Play configuration information. The MITE reads this memory during system startup.

Real-Time System Integration (RTSI)

The NI-TIO ASICs can access the RTSI bus to share triggers or to clock signals between DAQ devices. The RTSI bus on the NI 6602 and NI 6608 can share triggers between the two NI-TIOs.



Caution Only one NI-TIO or NI 660*X* device should drive a RTSI line at a time. Double-driving a RTSI line can damage the NI 660*X* device.

Other Features

The NI-TIO includes several other features for specific measurement or generation cases, including an interface to quadrature encoders for position and velocity measurement of rotating devices. Additionally, the NI-TIO second gate allows edge-separation measurements.

Using PXI with CompactPCI

Using PXI-compatible products with standard CompactPCI products is an important feature of the *PXI Specification*, Revision 1.0. Using a PXI-compatible plug-in device in a standard CompactPCI chassis enables you to use basic plug-in device functions, but PXI-specific functions are not available. For example, the RTSI bus on PXI-bus NI 660X devices is available in a PXI chassis, but not in a CompactPCI chassis.

The CompactPCI specification enables vendors to develop sub-buses that coexist with the basic PCI interface on the CompactPCI bus. Compatible operation is not guaranteed between CompactPCI devices with different sub-buses or between CompactPCI devices with sub-buses and PXI. The standard implementation for CompactPCI does not include these sub-buses. The NI PXI-6602 and NI PXI-6608 work in any standard CompactPCI chassis adhering to the *PICMG 2.0 R3.0, CompactPCI Specification*.

The J2 connector of the CompactPCI bus implements the PXI-specific features. The PXI device is compatible with any CompactPCI chassis whose sub-bus does not drive these lines.



Caution Driving these lines with the sub-bus may cause damage to the NI 660X device.

Even if the sub-bus is capable of driving these lines, the PXI device is still compatible with the CompactPCI chassis if the pins on the sub-bus are disabled by default. Refer to Table 1-1 for a list of the J2 pins the NI PXI-6602 and NI PXI-6608 use.

Table 1-1. Pins Used by NI PXI-660X Devices

NI PXI-6602/6608 Signal	PXI Pin Name	PXI J2 Pin Number
RTSI Trigger (05)	PXI Trigger (05)	B16, A16, A17, A18, B18, C18
RTSI Trigger (6)	PXI Star	D17
RTSI Clock	PXI Trigger (7)	E16
Reserved	LBR (7, 8, 10, 11, 12)	A3, C3, E3, A2, B2

Programming General-Purpose Counter/Timers

This chapter contains programming instructions for operating the circuitry on the NI 660*X* devices. The application descriptions presented in this chapter are broken into different application classes by functionality. Each application description example discusses the pertinent registers and bitfields used to program the application.

Programming the NI 660*X* devices involves writing to and reading from registers on the device. For a list of all device registers refer to Chapter 3, *Register Maps*.

The programming steps for counters and timing I/O and specific applications are explained later on in this chapter and in register descriptions. These operations are explained in terms of bitfields. A bitfield is defined as a group of contiguous bits that jointly perform a function. Using bitfields establishes an efficient mapping technique to the underlying hardware. Also, the programming style becomes very modular, so you can easily understand the functional description of every programming step.

PCI Local Bus

The NI 660X devices are fully compatible with the *PCI Local Bus Specification*, Revision 2.1. The PCI local bus is a high-performance, 32-bit bus with multiplexed address and data lines. The PCI system arbitrates and assigns resources through software, freeing you from manually setting switches and jumpers. You must configure the bus-related resources before attempting to execute a register-level program. Both the bus-related and data acquisition-related PCI configurations are described in the 6601/6602 User Manual.

PCI local bus devices can be used on any PCI bus system; however, this manual only discusses IBM-compatible systems.

PCI Initialization for the IBM Compatible System

The NI 660X devices use the MITE Application Specific Integrated Circuit (ASIC) chip as the PCI bus interface. NI designed this ASIC specifically for data acquisition. In order for the device to operate properly this chip must be configured. Ordinarily, NI-DAQ performs this function, but if you are not using NI-DAQ, as is the case with register-level programming, then you must configure the MITE.

The initialization is done by performing the following functions:

- 1. Detect whether the PCI bus is present using the appropriate PCI BIOS calls. This step verifies that the PCI bus is present.
- 2. Using the appropriate function, scan the PCI bus for all NI 660*X* devices to access the list of available PCI devices. PCI BIOS calls are used to find PCI devices that contain the NI Vendor ID (0x1093) and a valid NI 660*X* device ID. Refer to Table 2-1 for the list of device IDs. If a device is found matching these requirements, the pertinent information should be stored in a data structure.

Device ID
0x2C60
0x2C70
0x2880
0x1310
0x1360
0x2DB0
0x2CC0

Table 2-1. NI 660X Device IDs

3. Configure the device windows of the MITE and remap the device under 1 MB in the memory map. Refer to the *Remapping the NI 660X Device* section for more information.

Remapping the NI 660X Device

The NI 660X device uses two base address registers (BARs). BAR0 points to the base address for the MITE registers, while BAR1 points to the base address of the device registers such as the TIO counter/timer chip.

The size of each BAR is 4 KB and both are mapped into memory space. Therefore, you cannot use the C language I/O space read and write functions inp() and outp() to communicate with the NI 660X device. Both BARs usually map above 1 MB in the memory map, so you must know how to perform memory cycles to extended memory, which is difficult under operating systems such as Windows.

The following procedure provides you with the capability to remap the device under 1 MB making the communication much simpler. If you know how to perform memory calls under Windows or your operating system, remapping the device is both unnecessary and undesirable.

The pseudocode shown below demonstrates how to remap the device below 1 MB. If you do not want to remap the device, you must still complete steps 4 and 5 to enable the device window of the MITE. All values and bit masks are 32 bits and all pseudocode functions are of the format <code>function_name(address, data)</code>. This example assumes the new BARO address is 0xd000 and BAR1 address is 0xd1000. If you are using other addresses, you must make the appropriate changes.

1. Write the address where you want to remap the MITE (BAR0) to PCI configuration space offset 0x10. Using 0xd0000 for the new BAR0 address, make the following function call.

```
PCI Config Write (0x10, 0xd0000)
```

- 2. Write the value Oxaeae to offset 0x340 from the new MITE address.

 Mem Write (0xd0340, 0xaeae)
- 3. Write the address where you want to remap the device registers (BAR1) to configuration space offset (0x14) using 0xd1000 for the new BAR1 address.

```
PCI Config Write (0x14, 0xd1000)
```

4. Create the window_data_value by masking the device address. If you are not remapping the device, use the following code.

```
window_data_value = ((0xFFFFFFF00 AND BAR1) OR (0x8C))

If you are remapping the device, use the following code.
```

```
window_data_value = ((0xffffff00 AND 0xd1000) OR
(0x8C))
```

window data value = 0xd108C in this example.

5. Write the window data value to offset 0xc4 from the MITE (BAR0) address. If you are not remapping the device, use the following code.

```
Mem Write (BAR0 + 0xc4, window data value)
```

If you are remapping the device, use the following code.

```
Mem Write (0xd00c4, window data value)
```

6. Write 0x0 to offset 0xf4 from the MITE (BAR0) address. If you are not remapping the device, use the following code.

```
Mem Write (BAR0 + 0xf4, 0)
```

If you are remapping the device, use the following code.

```
Mem Write (0xd00f4, 0)
```

Functional Overview

You can use the NI 660X device in the counter-based applications outlined in Table 2-2. For more detailed descriptions of each application, refer to Chapter 3, *Device Overview*, of the 6601/6602 User Manual.

Table 2-2. Counter-Based Applications

Application Class	Application
Simple Counting	Simple event counting Gated event counting
Time Measurement	Single-period measurement Single pulse width measurement Two-signal edge-separation measurement
Simple-Pulse and Pulse-Train Generation	Single pulse generation Single triggered-pulse generation Retriggerable single-pulse generation Continuous pulse-train generation
Buffered Counting and Time Measurement	Buffered event counting (continuous) Buffered period measurement (continuous) Buffered semiperiod measurement (continuous) Buffered pulse width measurement (continuous) Buffered two-signal edge-separation measurement (continuous)
Position Measurement	Quadrature encoders

Reading Counter Values

This section explains how to read the values for disarmed and armed counters, and how to take buffered readings from counters.

Chapter 2

Disarmed Counters

Read the *Gi SW Save Register* to determine the counter value on a disarmed counter. Use this method for single-period and single-pulse measurements.

Armed Counters

Values for armed counters can change during the register read. If disarming the counter is impractical, as with simple event counting or position measurement, read the *Gi SW Save Register* twice. If both reads are the same, their value indicates the counter value. If the two reads are different, the counter value changed during one of the register reads. In this case, read *Gi SW Save Register* a third time. The third read is the correct counter value.

Buffered Readings

During a buffered measurement, the counter must save a value and continue counting. Setting the Gi_DMA_Enable bit in the Gi_DMA Config Register tells the counter to save the counter contents in either the Gi_HW Save Register or the Gi_SW Save Register. The counter uses the Gi_DMA Readbank bit in the Gi_DMA Status Register to tell the software which register to read. When Gi_DMA Read bit is set to 0, the most recent buffered counter value is in the Gi_HW Save Register. When Gi_DMA_Readbank is set to 1, the most recent buffered counter value is in the Gi_SW Save Register.

Counter/Timer Functions and Examples

The GPCTs provide counter/timer functions that are improved over those available on Am9513-based DAQ devices. Event counting, period measurement, pulse generation, and pulse-train generation are examples of existing counter/timer functions the NI-TIO supports. Enhancements to the existing counter/timer functions include quadrature encoder support and the ability to perform buffered-mode operations.

Event Counting

In event-counting functions, the counter counts events on the Selected Source input following the software arm. The software arm occurs when software sets the counter arm bit in the command register. The following actions are available in event counting:

- The Selected Source increments or decrements the counter.
- The Selected Gate indicates when to start and stop counting intervals or when to save the counter contents to the save register.
- The software either reads the counter value asynchronously from the Gi SW Save Register, or it reads the Gi HW Save Register or the Gi SW Save Register each time the hardware latches the counter value. In the latter case, interrupts notify the software that a save has occurred.
- AUX_LINE/UP_DOWN controls the direction of the counting.

Simple Event Counting

In simple event counting, the counter counts the number of pulses occurring on the Selected Source signal after the software arm. Software can read the counter contents at any time without disturbing the counting process. Figure 2-1 shows an example of simple event counting in which the counter counts five events on the Selected Source. The counter configuration is as follows:

Source: external signal

Gate: disabled

• Read from: Gi SW Save Register

Direction: up

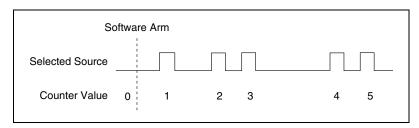


Figure 2-1. Simple Event Counting

Simple Gated-Event Counting

Simple gated-event counting is similar to simple event counting, but the counting process in simple gated-event counting is gated—halted and resumed—through the Selected Gate. When the Selected Gate is active, the counter counts pulses occurring on the Selected Source signal after the software arm. When the Selected Gate is inactive, the counter retains the current count value. Figure 2-2 shows an example of simple gated-event counting in which the gate action allows the counter to count only five of the pulses on the Selected Source. The counter configuration is as follows:

Source: external signalGate: external signal

• Read from: Gi SW Save Register

• Direction: up

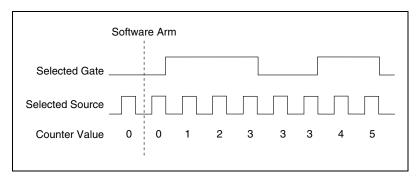


Figure 2-2. Simple Gated-Event Counting

Buffered Cumulative Event Counting

Buffered cumulative event counting is similar to simple event counting, but the Selected Gate signal in buffered cumulative event counting indicates when to save the counter value to the Gi HW Save Register. The active Selected Gate edge latches the count value into the Gi SW Save Register. Counting continues uninterrupted regardless of the Selected Gate activity. An interrupt notifies the CPU after each active Selected Gate edge so that the ISR can read the result from the Gi HW Save Register. Figure 2-3 shows cumulative event counting in which the gate action causes the Gi HW Save Register to save the counter contents twice. The counter configuration is as follows:

• Source: external signal

Gate: external signal

Trigger mode: gate ignored

Interrupt on: DMA interrupt

• Read from: determined by Gi DMA Status Register

• Direction: up

• Load on gate: do not reload on gate



Caution Reading the value of a counter outside the ISR may result in data loss.

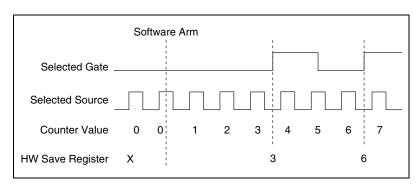


Figure 2-3. Cumulative Event Counting

Buffered Noncumulative Event Counting

Buffered noncumulative event counting is similar to simple event counting, but buffered noncumulative event counting has multiple counting intervals. The Selected Gate signal indicates the boundary between consecutive counting intervals. The counter counts the number of pulses occurring on the Selected Source signal after the software arm. Each active edge of the Selected Gate signal latches the count value for the current counting interval into either the Gi HW Save Register or the Gi SW Save Register and reloads the counter with the initial value to begin the next counting interval. An interrupt notifies the CPU after each counting interval so that the interrupt software can read the result from the Gi HW Save Register. Figure 2-4 shows buffered noncumulative event counting with two counting intervals. Three events are counted in each of the two counting intervals. The counter configuration is as follows:

• Source: external signal

• Gate: external signal

Trigger mode: gate ignored

Load on: gateInterrupt: on gate

Chapter 2

Read from: determined by Gi DMA Status Register

• Direction: up

Load on gate: reload on gate

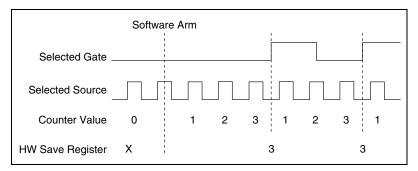


Figure 2-4. Buffered Noncumulative Event Counting

Position Measurement

In position measurement functions, the counter tracks the position of a quadrature encoder.

Relative Position Measurement

In relative position sensing, the counter tracks the relative position of the position encoder. Two types of events are possible: movement in the positive direction and movement in the negative direction. When Channel A leads Channel B, the counter increments. When Channel B leads Channel A, the counter decrements. The number of increments and decrements per cycle depends on the type of encoding: X1, X2, or X4. On NI-TIO counters, Channel A is hardwired to the default counter source pin, Channel B is hardwired to the AUX_LINE pin, and Channel Z is hardwired to the gate pin.

The software initially loads the counter with a value corresponding to the initial position of the object. Upon reaching terminal count (TC), the counter rolls over. You can obtain the relative object position at any time by asynchronously reading the counter value. Figure 2-5 shows an example of relative position sensing. The counter configuration is as follows:

• Encoder counting mode: X4

Source select: internal timebase

• Read from: Gi SW Save Register

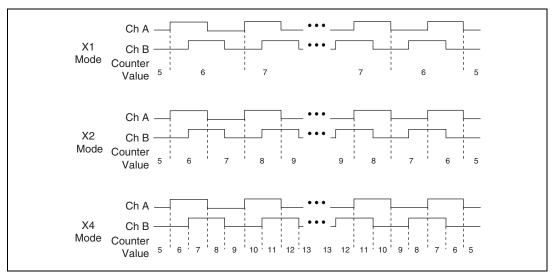


Figure 2-5. Relative Position Sensing

Time Measurement

In time measurement functions, the counter uses the Selected Source as a timebase to measure the time interval between events on the Selected Gate signal. The following actions are available in time measurement:

- Rising edges on the Selected Source can increment or decrement the counter during the measurement interval.
- Counting can begin and end on any two of the Selected Gate edges—rising, falling, or both.
- The Gi HW Save Register or the Gi SW Save Register can save the counter value upon completion of the measurement.

Single-Period Measurement

In single-period measurement, the counter uses the Selected Source to measure the period of the signal present on the Selected Gate input. The counter counts the number of rising edges occurring on the Selected Source between two active edges of the Selected Gate. At the completion of the period interval for the Selected Gate, the *Gi SW Save Register* contains the last counter value. Figure 2-6 shows a single-period measurement in which the period of the Selected Gate is five Selected Source rising edges.

The counter configuration is as follows:Source: internal clock

• Gate: external signal

Gate mode: falling edgeSecond gate: selected gate

· Second gate mode: on

Second gate polarity: noninverted

Count once: true

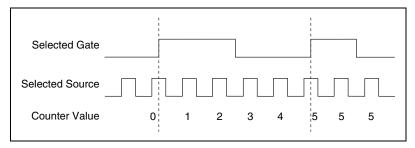


Figure 2-6. Single-Period Measurement

Single Pulse Width Measurement

In single pulse-width measurement, the counter uses the Selected Source to measure the pulse width of the signal present on the Selected Gate input. The counter counts the number of rising edges occurring on the Selected Source while the Selected Gate signal remains in an active state. At the completion of the pulse-width interval for the Selected Gate, the *Gi SW Save Register* retains the counter value for software read. Figure 2-7 shows a single pulse-width measurement in which the pulse width of the Selected Gate is five Selected Source rising edges. The counter configuration is as follows:

Source: internal

Gate: external signal

• Gate mode: level

Gate polarity: inverted

Second gate: selected gate

Second gate mode: on

• Second gate polarity: inverted

Count once: true

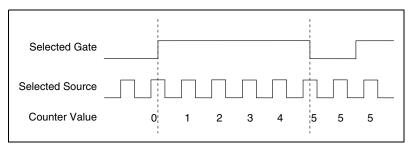


Figure 2-7. Single Pulse-Width Measurement

Buffered Period Measurement

Buffered period measurement is similar to single-period measurement, except that buffered period measurement takes measurements for multiple periods. The counter uses the Selected Source to measure the time interval between two active edges of the signal present on the Selected Gate input, counting the number of rising edges that occur on the Selected Source between each pair of active edges of the Selected Gate. At the completion of each period interval for the Selected Gate, the *Gi* HW Save Register or the *Gi SW Save Register* latches the counter value for software read. An interrupt notifies the CPU after each period so that the interrupt software can read the value in the *Gi* HW Save Register. Figure 2-8 shows two periods of a buffered period measurement in which the period is three Selected Source rising edges. The counter configuration is as follows:

Source: internal clockGate: external signal

Gate mode: falling edge

Second gate: selected gate

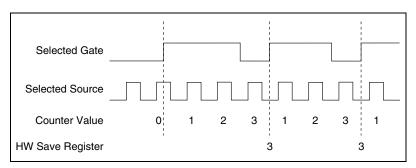
• Second gate mode: on

• Second gate polarity: non-inverted

• Read from: determined by Gi DMA Status Register

Interrupt on: DMA interrupt

Count once: false



Chapter 2

Figure 2-8. Buffered Period Measurement

Buffered Pulse Width Measurement

Buffered pulse-width measurement is similar to single pulse-width measurement, but buffered pulse-width measurement takes measurements over multiple pulses. The counter uses the Selected Source to measure the pulse width of the signal present on the Selected Gate input, counting the number of rising edges that occur on the Selected Source while the Selected Gate remains in an active state. At the completion of each pulse width interval for the Selected Gate, the Gi HW Save Register or the Gi SW Save Register latches the counter value for software read. An interrupt notifies the CPU after each period so that the interrupt software can read the value in the Gi HW Save Register. Figure 2-9 shows two pulse widths of a buffered pulse-width measurement in which the first pulse width is three Selected Source rising edges and the second pulse width is two Selected Source rising edges. The counter configuration is as follows:

Source: internal

• Gate: external signal

• Gate mode: level

• Gate polarity: inverted

Second gate: selected gate

Second gate mode: on

• Second gate polarity: inverted

• Read from: determined by *Gi DMA Status Register*

• Interrupt on: DMA interrupt

Count once: false

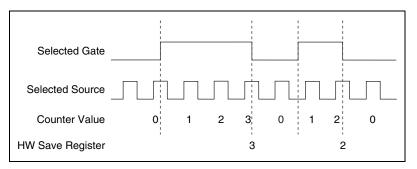


Figure 2-9. Buffered Pulse-Width Measurement

Pulse Generation

In pulse generation functions, the counter generates a single pulse of specified duration following the software arm. The software arm occurs when software sets the counter arm bit in the command register. The following actions are available in pulse generation:

- The counter uses the Selected Source as a timebase to generate the pulse.
- The user specifies the pulse parameters in terms of periods of the Selected Source input.
- The Selected Gate can serve as a trigger signal to generate a pulse after the first active gate edge or after each active gate edge.

Single Pulse Generation

The single pulse generation function generates a single pulse with programmable delay and programmable pulse width following the software arm. Because the counter uses the Selected Source as a timebase to generate the pulse, specify the pulse parameters in terms of periods of the Selected Source input. Software implements pulse generation by loading the delay value into the counter, loading the pulse-width value into the load register, and programming the counter output G_OUT to change states on counter TC. Figure 2-10 shows the generation of a single pulse with a pulse delay of four and a pulse width of three. The counter configuration is as follows:

Source: internal

Gate: none

Output mode: toggle on TC

Direction: down

Count once: true

Load on: TC

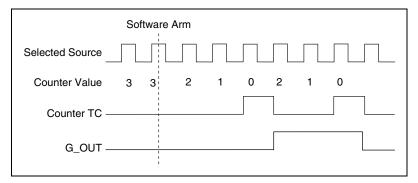


Figure 2-10. Single Pulse Generation

Pulse-Train Generation

In the pulse-train generation functions, the counter generates a continuous stream of pulses of specified interval and duration following the software arm and an optional hardware trigger. The software arm occurs when software sets the counter arm bit in the NI-TIO register. The following actions are available in pulse-train generation:

- The pulse parameters can be specified in terms of periods of the Selected Source input.
- The Selected Gate input can serve as a trigger signal to generate a stream of pulses only after the active gate edge occurs.

Continuous Pulse-Train Generation

This function generates a sequence of pulses with programmable pulse interval and pulse width. Because the counter uses the Selected Source as a timebase to generate the pulses, specify the programmable parameters in terms of periods of the Selected Source input. Pulse-train generation is implemented in software by loading the pulse parameters into the counter and load registers, and by programming the counter to switch load registers on every counter TC. Figure 2-11 shows the generation of three pulses with a delay from trigger of three, a pulse interval of four, and a pulse width of three. The counter configuration is as follows:

Source: internal

Gate: none

Output mode: toggle on TC

Direction: down

Count once: false

Load on: TC

Trigger mode: only gate edge starts

Reload source switching: true

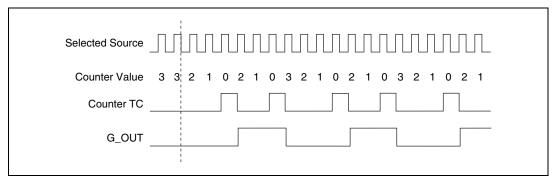


Figure 2-11. Continuous Pulse-Train Generation

Single Triggered Pulse Generation

Single triggered pulse generation is similar to single pulse generation; the Selected Gate in single triggered pulse generation provides a trigger function. An active Selected Gate edge following the software arm causes the counter to generate a single pulse with programmable delay and programmable pulse width. Specify the programmable parameters in terms of periods of the Selected Source input. Single triggered pulse generation is implemented in software by loading the delay value into the counter, loading the pulse-width value into the load register, programming the counter output G OUT to change states on counter TC, and configuring the Selected Gate as the trigger signal. Figure 2-12 shows the generation of a single pulse with a pulse delay of four and a pulse width of three. The counter configuration is as follows:

Source: internal

Gate: external signal

Output mode: toggle on TC

Direction: down Count once: true

Load on: TC

Trigger mode: gate edge only starts

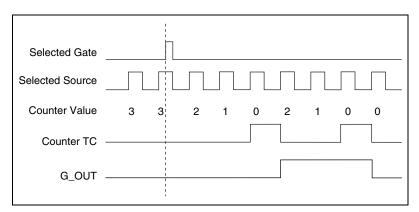


Figure 2-12. Single Triggered Pulse Generation

Register Maps

This chapter contains NI-TIO and MITE register maps and register descriptions.

NI-TIO

The NI-TIO (0) location is PCI BAR1, offset 0x0. The NI-TIO (1) location, which is only on the NI 6602 and NI 6608 devices, is PCI BAR1, offset 0x800.

Register Map and Descriptions

This section includes a register map and a bit-by-bit description of each register in the NI-TIO. Table 3-1 provides the register name, the register address offset from the device base address, BAR1, the type of register—read-only or write-only, and the size of the register in bits. Registers are grouped in the table by offset, and the register descriptions following the table are organized alphabetically.

Table 3-1. TIO Register Address Map

Register Name	Offset (Hex)	Туре	Size
G0 Interrupt Acknowledge	0x004	Write-only	16-bit
G0 Status Register	0x004	Read-only	16-bit
G1 Interrupt Acknowledge	0x006	Write-only	16-bit
G1 Status Register	0x006	Read-only	16-bit
G01 Status Register	0x008	Read-only	16-bit
G0 Command Register	0x00C	Write-only	16-bit
G1 Command Register	0x00E	Write-only	16-bit
G0 HW Save Register	0x010	Read-only	32-bit
G1 HW Save Register	0x014	Read-only	32-bit
G0 SW Save Register	0x018	Read-only	32-bit

Table 3-1. TIO Register Address Map (Continued)

Register Name	Offset (Hex)	Туре	Size
G1 SW Save Register	0x01C	Read-only	32-bit
G0 Mode Register	0x034	Write-only	16-bit
G01 Joint Status 1 Register	0x036	Read-only	16-bit
G1 Mode Register	0x036	Write-only	16-bit
G0 Load A Register	0x038	Write-only	32-bit
G01 Joint Status 2 Register	0x03A	Read-only	16-bit
G0 Load B Register	0x03C	Write-only	32-bit
G1 Load A Register	0x040	Write-only	32-bit
G1 Load B Register	0x044	Write-only	32-bit
G0 Input Select Register	0x048	Write-only	16-bit
G1 Input Select Register	0x04A	Write-only	16-bit
G0 Autoincrement Register	0x088	Write-only	16-bit 16-bit 16-bit 16-bit 16-bit
G1 Autoincrement Register	0x08A	Write-only	
G01 Joint Reset Register	0x090	Write-only	
G0 Interrupt Enable	0x092	Write-only	
G1 Interrupt Enable	0x096	Write-only	
G0 Counting Mode Register	0x0B0	Write-only	
G1 Counting Mode Register	0x0B2	Write-only	16-bit
G0 Second Gate Register	0x0B4	Write-only	16-bit
G1 Second Gate Register	0x0B6	Write-only	16-bit
G0 DMA Config Register	0x0B8	Write-only	16-bit
G0 DMA Status Register	0x0B8	Read-only	16-bit
G1 DMA Config Register	0x0BA	Write-only	16-bit
G1 DMA Status Register			16-bit
G2 Interrupt Acknowledge			16-bit
G2 Status Register	0x104	Read-only	16-bit

 Table 3-1.
 TIO Register Address Map (Continued)

Register Name	Offset (Hex)	Туре	Size
G3 Interrupt Acknowledge	0x106	Write-only	16-bit
G3 Status Register	0x106	Read-only	16-bit
G23 Status Register	0x108	Read-only	16-bit
G2 Command Register	0x10C	Write-only	16-bit
G3 Command Register	0x10E	Write-only	16-bit
G2 HW Save Register	0x110	Read-only	32-bit
G3 HW Save Register	0x114	Read-only	32-bit
G2 SW Save Register	0x118	Read-only	32-bit
G3 SW Save Register	0x11C	Read-only	32-bit
G2 Mode Register	0x134	Write-only	16-bit
G23 Joint Status 1 Register	0x136	Read-only	16-bit
G3 Mode Register	0x136	Write-only	16-bit 32-bit 16-bit 32-bit 32-bit 32-bit
G2 Load A Register	0x138	Write-only	
G23 Joint Status 2 Register	0x13A	Read-only	
G2 Load B Register	0x13C	Write-only	
G3 Load A Register	0x140	Write-only	
G3 Load B Register	0x144	Write-only	
G2 Input Select Register	0x148	Write-only	16-bit
G3 Input Select Register	0x14A	Write-only	16-bit
G2 Autoincrement Register	0x188	Write-only	16-bit
G3 Autoincrement Register	0x18A	Write-only	16-bit
G23 Joint Reset Register	0x190	Write-only	16-bit
G2 Interrupt Enable	0x192	Write-only	16-bit 16-bit
G3 Interrupt Enable	0x196	Write-only	
G2 Counting Mode Register	0x1B0	Write-only	16-bit
G3 Counting Mode Register	0x1B2	Write-only	16-bit

Table 3-1. TIO Register Address Map (Continued)

Register Name	Offset (Hex)	Туре	Size
G3 Second Gate Register	0x1B6	Write-only	16-bit
G2 Second Gate Register	0x1B4	Write-only	16-bit
G2 DMA Config Register	0x1B8	Write-only	16-bit
G2 DMA Status Register	0x1B8	Read-only	16-bit
G3 DMA Config Register	0x1BA	Write-only	16-bit 16-bit 32-bit 32-bit 32-bit
G3 DMA Status Register	0x1BA	Read-only	
Reset Control Register	0x700	Write-only	
Chip Signature Register	0x700	Read-only	
Clock Config Register	0x73C	Write-only	
Global Interrupt Status Register	0x754	Read-only	32-bit
DMA Configuration Register	0x76C	Write-only	32-bit
Global Interrupt Config Register	0x770	Write-only	32-bit

Chip Signature Register

Ty _j Siz	Address Offset: Type: Size: Bit Map:						
31	30	29	28	27	26	25	24
0	0	0	0	Version3	Version2	Version1	Version0
23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8
7	6	5	4	3	2	1	0

Bit Name Description

27–24 Version<3..0> The revision of the chip.

Clock Config Register

Ty _] Siz		0x73C Write 32-bit					
31	30	29	28	27	26	25	24
0	0	0	0	0	0	0	0
23	22	21	20	19	18	17	16
0					0		0
0	0	Counter_ Swap	0	0	0	0	0
15	14	13	12	11	10	9	8
0	0	0	0	0	0	0	0
7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0

Bit Name Description

21 Counter_Swap

Setting this bit swaps the dedicated counter pins (SRC, GATE, UP/DOWN, OUT) between counter locations 0 through 3 and 4 through 7. This setting allows two NI-TIO ASICs to be configured to use all eight dedicated counter locations. The addressing of the counters remains the same. This setting also applies to dedicated pins, such as the Quadrature and Output. The mapping is as follows:

0 < -> 4

1 <-> 5

2 <-> 6

3 <-> 7

DMA Configuration Register

Ado	dress Offset:	: 0x76C					
Typ	pe:	Write					
Size	e :	32-bit					
Bit	Map:						
31	30	29	28	27	26	25	24
DMA_3_ Reset	0	0	DMA_3_ Select_4	DMA_3_ Select_3	DMA_3_ Select_2	DMA_3_ Select_1	DMA_3_ Select_0
23	22	21	20	19	18	17	16
DMA_2_ Reset	0	0	DMA_2_ Select_4	DMA_2_ Select_3	DMA_2_ Select_2	DMA_2_ Select_1	DMA_2_ Select_0
15	14	13	12	11	10	9	8
DMA_1_ Reset	0	0	DMA_1_ Select_4	DMA_1_ Select_3	DMA_1_ Select_2	DMA_1_ Select_1	DMA_1_ Select_0
7	6	5	4	3	2	1	0
DMA_0_ Reset	0	0	DMA_0_ Select_4	DMA_0_ Select_3	DMA_0_ Select_2	DMA_0_ Select_1	DMA_0_ Select_0

Bits	Name	Description
31, 23, 15, 7	DMA_<30>_F	Direct Memory Access Reset. Writing a one to this bit resets the toggle flip flop used to track 16-bit DMA accesses. The toggle flip flop points the DACK to the proper data lane. This bit should be set as part of initializing DMA. The bit clears automatically after a write.
28–24	DMA_3_Select	_<40>
20–16	DMA_2_Select	_<40>

- 12-8 DMA_1_Select_<4..0>
- 4-0 DMA_0_Select_<4..0>

These fields are used to select which internal DMA resource is routed to the corresponding DRQ pin. The mapping is as follows:

- 0—Counter 0
- 1—Counter 1
- 2—Counter 2
- 3—Counter 3
- 31—Nothing selected; DRQ pin goes to a high-impedance state; reset state

GO Interrupt Enable Register, G2 Interrupt Enable Register

Ty Siz	Address Offsets: Type: Size: Bit Map:		(G0), 0x192	2 (G2)			
15	14	13	12	11	10	9	8
0	0	0	0	0	0	0	0
7	6	5	4	3	2	1	0
0	G0_TC_ Interrupt_	0	0	0	0	0	0

Bit Name	Description
----------	-------------

6 G0_TC_Interrupt_Enable

Enable

G0 Terminal Count Interrupt Enable. Setting this bit allows a terminal count interrupt to assert the counter interrupt.

G01 Joint Reset Register, G23 Joint Reset Register

5

Gi_Reset

3, 2

Address Offsets:			(G01), 0x19	90 (G23)								
Tyl	pe:	Write	Write 16-bit									
Siz	e:	16-bit										
Bit	Map:											
15	14	13	12	11	10	9	8					
0	0	0	0	0	0	0	0					

Bits	s Na	ıme	Descripti	on			
0	0	0	0	G1_Reset	G0_Reset	0	0

Writing this strobe bit to 1 resets the counter. This bit automatically clears, and the counter is disarmed.

G01 Joint Status 1 Register

Ad	Address Offset:						
Ty	Type:						
Siz	Size:						
Bit	Bit Map:						
15	14	13	12	11	10	9	8
X	X	X	Serial_In_ Progress	X	X	X	X

7	6	5	4	3	2	1	0
X	X	X	X	G1_Gate	G0_Gate	G1_Bank	G0_Bank

Bits	Name	Description
12	Serial_In_Progr	ess This bit indicates that hardware serial-to-parallel conversion is in progress.
3, 2	Gi_Gate	This bit reads the state of the selected gate signal after polarity selection.
1, 0	Gi_Bank	This bit indicates which bank of A and B registers the counter is using.
		0—Bank X 1—Bank Y

G01 Joint Status 2 Register, G23 Joint Status 2 Register

Address Offsets: 0x03A (G01), 0x13A (G23)

Type: Read Size: 16-bit

Bit Map:

15	14	13	12	11	10	9	8
G1_	G0_	G1_HW_	G0_HW_	X	X	X	X
Permanent_	Permanent_	Save	Save				
Stale_Data	Stale_Data						

7	6	5	4	3	2	1	0
X	X	X	X	X	X	G1_Output	G0_Output

Bits	Name	Description
15, 14	Gi_Permanent_	_Stale_Data
		This bit is set if the Gi_Stale_Data bit, located on the G01
		Status Register, G23 Status Register, is set at any time
		during counter operation. A counter reset clears this bit.
13, 12	Gi HW Save	Hardware Save. This bit indicates that it latched valid data
13, 12	Gi_IIW_Save	and is ready to read.
		•
1, 0	Gi_Output	This bit allows the counter output state to be read back.
		The read occurs after the polarity selection.

G01 Status Register, G23 Status Register

Address Offset: Type:		Read					
Sizo Bit	e: Map:	16-bit					
15	14	13	12	11	10	9	8
X	X	G1_TC_ Error	G0_TC_ Error	G1_No_ Load_ Between_ Gates	G0_No_ Load_ Between_ Gates	G1_Armed	G0_Armed
7	6	5	4	3	2	1	0
G1_Stale_ Data	G0_Stale_ Data	G1_Next_ Load_ Source	G0_Next_ Load_ Source	G1_ Counting	G0_ Counting	G1_Save	G0_Save

Bits	Name	Description
13, 12	Gi_TC_Error	Terminal Count Error. This bit sets when two terminal count interrupts occur without an acknowledgment. The Gi_TC_Error_Confirm bit, located on the G0 Interrupt Acknowledge Register, G2 Interrupt Acknowledge Register, clears this bit.
11, 10	Gi_No_Load_B	This bit indicates that a load did not occur between the selected gate edges. The Gi_Load, located on the Gi Command Register, or Gi_Reset bit, located on the G01 Joint Reset Register, G23 Joint Reset Register, clears this bit.
9, 8	Gi_Armed	This bit sets when the counter is armed.
7, 6	Gi_Stale_Data	This error bit sets if two relevant GATE edges occur without a SRC edge between them. Because reaction to GATE edges depends on the SRC edges, it may have generated incorrect data. The synchronous counting mode is one way to prevent this error. In this mode, the Stale bit updates on each GATE edge and reflects the state of the Gi HW Save Register. The Gi_Permanent_Stale_Data bit,

located in the G01 Joint Status 2 Register, G23 Joint Status 2 Register, records the error until it is cleared.

5, 4 Gi_Next_Load_Source

This bit indicates which load bank to load from next.

- 0—Load register A
- 1—Load register B
- 3, 2 Gi_Counting

Gi_Counting is asserted when the counter is armed and enabled for counting. It reflects the state of the terms used for GATE or TC disabling the counter. When the counter is not armed, the bit is ignored.

1, 0 Gi_Save

Gi_Save indicates the state of the Gi SW Save Register. It sets when the Gi SW Save Register is latched for reading.

Address Offsets: Type: Size: Bit Map:		Write	0x096 (G1), 0x196 (G3) Write 16-bit					
15	14	13	12	11	10	9	8	
0	0	0	0	0	0	G1_TC_ Interrupt_ Enable	0	
7	6	5	4	3	2	1	0	

Description

9 G1_TC_Interrupt_Enable

G1 Terminal Count Interrupt Enable. Setting this bit allows a terminal count interrupt to assert the counter interrupt.

G23 Joint Status 1 Register

Address Offset: Type: Size: Bit Map:		0x136 Read 16-bit					
15	Map:	13	12	11	10	9	8
X	X	X	X	X	X	X	X
7	6	5	4	3	2	1	0
X	X	X	X	G3_Gate	G2_Gate	G3_Bank	G2_Bank

Bits	Name	Description
3, 2	Gi_Gate	This bit reads the state of the selected gate signal after polarity selection.
1, 0	Gi_Bank	This bit indicates which bank of A and B registers the counter is using.
		0—Bank X 1—Bank Y

Gi Autoincrement Register

Address Offset: 0x088, 0x0A, 0x188, 0x18A

Type: Write Size: 16-bit

Bit Map:

15	14	13	12	11	10	9	8
0	0	0	0	0	0	0	0

7	6	5	4	3	2	1	0
Gi_Autoinc rement_7	Gi_Autoinc rment_6	Gi_Autoinc rement_5	Gi_Autoinc rement_4	Gi_Autoinc rement_3	Gi_Autoinc rement_2	Gi_Autoinc rement_1	Gi_Autoinc rement_0

Bits Name Description

7–0 Gi_Autoincrement_<7..0>

This field holds a fixed value that is added to the Load A register after a counter reload, so the load value is increased each time. This functionality is included to support equivalent time sampling through pulse generation.



Note The *G01 Joint Reset Register*, *G23 Joint Reset Register* did not reset this register, so it should be programmed to zero.

Gi Command Register

Address Offsets: 0x00C (G0), 0x00E (G1), 0x10C (G2), 0x10E (G3)

Write Type: Size: 16-bit

Bit Map:

15	14	13	12	11	10	9	8
Gi_Disarm_ Copy	Gi _Save_ Trace_ Copy	Gi_Arm_ Copy	Gi_Bank_ Switch_ Enable	Gi_Bank_ Switch_ Mode	Gi_Bank_ Switch_ Start	Gi_Little_ Big_ Endian	Gi_ Synchronized_ Gate

7	6	5	4	3	2	1	0
Gi_Write_ Switch	Gi_Up/ Down_1	Gi _Up/ Down_0	Gi_Disarm	0	Gi_Load	Gi_Save_ Trace	Gi_Arm

Bits Description Name 15 Gi_Disarm_Copy Setting this bit disarms the other counter in the pair.

The copy bits allow a single write to perform a command on both counters in the pair.

14 Gi Save Trace Copy

> This bit controls the Gi SW Save Register. When Gi Save Trace Copy is clear, the Gi SW Save Register is open and tracing the counter. When set, the Gi SW Save *Register* goes into the latched mode after the next clock edge to assure valid data was latched. The latching process is complete when the Gi_Save bit, located on the G01 Status Register, G23 Status Register, is set. The copy bits allow a single write to perform a command on both counters in the pair.

13 Gi_Arm_Copy Setting this bit arms the other counter in the pair. The counter remains armed until disabled in hardware or by the Gi_Disarm_Copy bit.

12 Gi_Bank_Switch_Enable

Setting this bit enables bank switching. When the counter is armed, this bit enables switching between the two banks of A and B Load registers, referred to as X and Y. If the counter is disarmed, this bit selects the bank written when accessing the Load A and Load B registers.

0-Writes Bank X

1-Writes Bank Y

11 Gi_Bank_Switch_Mode

If bank switching is enabled, this bit selects the source that causes a bank switch to occur during operation.

0—Gate

1—Software

10 Gi_Bank_Switch_Start

Setting this bit causes a bank switch on the condition determined by the Gi_Bank_Switch_Mode bit. The bit automatically clears after the bank switch.

9 Gi_Little_Big_Endian

When using automatic interrupt acknowledgement, this bit determines which segment of the load or save register triggers the acknowledgement.

0—Low register, bits 15–0

1—High register, bits 31–16

8 Gi Synchronize Gate

Setting this bit synchronizes the GATE signal to the counter clock. This bit should be enabled, unless the gate signal is definitely synchronized to the SRC and there is sufficient setup time.

7 Gi_Write_Switch

This bit controls load register writes to the inactive bank. When the bit is clear, writes to Load A always change A. When the bit is set, writes to Load A are directed to the inactive bank.

6, 5	Gi_Up/Down_<	01>
	•	This bitfield determines the counting direction.
		0—Always down
		1—Always up
		2—Hardware selected based on the UP/DOWN
		I/O pin: $0 = down$, $1 = up$
		3—Hardware selected based on the internal
		GATE, $0 = down$, $1 = up$
4	Gi_Disarm	Setting this bit disarms the counter.
2	Gi_Load	This strobe bit uses software to load the initial counter value. When the bit is asserted, the selected load register (A or B) transfers to the counter.
1	Gi_Save_Trace	This bit controls the <i>Gi SW Save Register</i> . When Gi_Save_Trace is clear, the <i>Gi SW Save Register</i> is open and tracing the counter. When set, the register goes into the latched mode after the next clock edge to assure valid data was latched. The latching process is complete when the Gi_Save bit, located on the <i>G01 Status Register</i> , $G23$ <i>Status Register</i> , is set.
0	Gi_Arm	Setting this bit arms the counter. The counter remains armed until disabled in hardware or by the Gi_Disarm bit.

Gi Counting Mode Register

Address Offsets: 0	0x0B0 (G0),	0x0B2 (G1),	0x1B0 ((G2),	0x1B2 (G3)
---------------------------	-------------	-------------	---------	-------	---------	-----

Type: Write **Size:** 16-bit

Bit Map:

15	14	13	12	11	10	9	8
0	0	Gi_ Alternate_ Sync	Gi_Prescale	0	0	0	0

7	6	5	4	3	2	1	0
0	Gi_Index_ Phase_1	Gi_Index_ Phase_0	Gi_Index_ Mode	0	Gi_ Counting_ Mode_2	Gi_ Counting_ Mode_1	Gi_ Counting_ Mode_0

Bits Name Description

13 Gi_Alternate_Sync

Alternate Synchronization. When synchronizing a signal, the NI-TIO uses the falling edge of the clock when an internal timebase is chosen. For other signals, the clock may free run, in which case the selected source synchronizes the signal, and a delayed version clocks the counter.

Setting the Gi_Alternate_Sync bit adds an additional synchronization bit to the NI-TIO. When set, the rising source edge synchronizes the signal and clocks the counter, which gives a full state of setup and delays the reaction one clock. This mode must be enabled if the counter is clocked above 40 MHz, including cases in which TIMEBASE 3 is implicitly selected, such as in synchronous counting and quadrature modes.

12 Gi Prescale

When this bit is enabled, the high-speed counter divides the selected source by eight before clocking the counter. This mode allows signal frequency to be measured, even when the frequency is above the 80 MHz limit for the counters.

6, 5 Gi_Index_Phase_<0..1>

The index phase field determines the state of the A and B quadrature signals and is where the index, or Z signal, is acted upon. The Z index can span multiple phases of the quadrature, but it is recommended that you reload the counter in only one of the phases.

0—A low, B low

1—A low, B high

2—A high, B low

3—A high, B high

4 Gi_Index_Mode

Gi_Index_Mode affects the new counting modes in the following ways:

Quadrature mode—The Z input signal, or index, can reload the counter in a particular phase. The counter reloads when this bit is set, A and B match the index phase, and the Z input is high.

Two-pulse mode—The counter reloads while Z is loaded.

Source synchronous mode—Setting this bit disables the edge detector on the source signal that requires it to be synchronous.

2, 0 Gi_Counting_Mode_<0..2>

This bitfield adds counting modes to the NI-TIO GPCT for interfacing to encoders and other new applications.

0—One. Normal counting mode.

1—Quadrature Mode X1. This mode allows direct interfacing to quadrature encoders for position and velocity measurement. The encoder has two and sometimes three signals: signal A connects to the dedicated source pin of the counter; signal B connects to the UP/DOWN pin; and signal Z connects to the GATE pin. Signals A and B pulse with each movement and are 90 degrees out of phase to indicate direction. The Z signal reloads the counter when the Gi_Index_Mode bit is enabled. The X1 mode increments or decrements the counter once per total phase.

- 2—Quadrature Mode X2. This mode counts on both edges of the A signal. Two counts per cycle are recorded.
- 3—Quadrature Mode X4. This mode counts on both edges of the A and B signals. Four counts per cycle are recorded.
- 4—Two-Pulse Mode. In this mode, a rising edge on the A signal increments the counter, and a rising edge on the B signal decrements the counter. The counter reloads while the Z signal is high and enabled.
- 6—Synchronous Source Mode. Several counter features, such as hardware save and load, depend on source edges to operate. However, it is sometimes necessary to measure event rates down to 0 Hz. Synchronous Source Mode runs the counter at maximum timebase, but enables it on a source edge to mimic running off that source while providing a free-running clock.

Gi DMA Config Register

Address Offsets:	0x0B8 (G0),	0x0BA (G1),	, 0x1B8 (G2)	0x1BA (G3)
------------------	-------------	-------------	--------------	------------

Type: Write Size: 16-bit

Bit Map:

15	14	13	12	11	10	9	8
0	0	0	0	0	0	0	0

7	6	5	4	3	2	1	0
0	0	0	0	0	Gi_DMA_ Int	Gi_DMA_ Write	Gi_DMA_ Enable

Bits Name Description

2 Gi DMA Int

Direct Memory Access Interrupt. This bit uses DMA mode to implement programmed I/O (PIO) operations. When set, the counter interrupt asserts with the counter DMA request (DRQ) signal, indicating that service is needed. If reading data, the software reads either the Gi HW Save Register or the Gi SW Save Register, as determined by the Gi_DMA_Readbank bit, located on the Gi DMA Status Register. Write data to the appropriate A or B register.

1 Gi_DMA_Write Direct Memory Access Write. This bit indicates the direction of the DMA operation.

0—DMA controller reads data from the NI-TIO save registers

1—DMA controller writes data to the NI-TIO load registers

0 Gi_DMA_Enable

Direct Memory Access Enable. When this bit is set, the NI-TIO adds a new DMA mode for streaming counts into or out of the counters. The read mode uses both the hardware and the *Gi SW Save Register* as a two-element FIFO in order to increase the rate at which pulse or period measurements are made. When using a DMA controller (asserted DACK), the DACK reads are automatically

routed to the proper register, and data is alternately stored on gate edges. When using PIO, the Gi_DMA_Readbank bit, located on the Gi DMA Status Register, indicates the register at the head of the FIFO.

For pulse generation, DMA can reload the load register when a bank switch occurs. DRQ asserts on the bank switch and clears when the last load register is written. The Gi_Write_Switch and Gi_Little_Big_Endian bits, located on the , determine the last load register. If Gi_Write_Switch is clear, writes are directed to Load B, and DRQ clears on a write to the half of Load B as determined by Gi_Little_Big_Endian. If Gi_Write_Switch is true, the first write goes to Load B, DRQ remains asserted, and the second write goes to Load A, which clears DRQ.

Gi DMA Status Register

Address Offsets: 0x0B8 (G0), 0xBA (G1), 0x1B8 (G2), 0x1BA (G3)

Type: Read Size: 16-bit

Bit Map:

Gi_DRQ_ Gi_DRQ_ Gi_DMA_ X X X X X X X X X X X X X X X X X X X	15	5	14	13	12	11	10	9	8
Status Eiio Readualik			i_DRQ_ Error	Gi_DMA_ Readbank	X	X	X		X

	7	6	5	4	3	2	1	0
2	X	X	X	X	X	X	X	X

Bits	Name	Description
15	Gi_DRQ_Status	DMA Request Status. This bit is set when the counter needs DMA service and clears automatically when the request is serviced.
14	Gi_DRQ_Error	DMA Request Error. This bit is set when a DMA overflow error occurs on a read operation and when an underflow error occurs on a write operation. When reading, this bit sets if a save request occurs when the FIFO is full and another DMA read follows. The save request does not corrupt the data when the FIFO is received after completion. When writing, an error is set if the bank switches while DRQ is still set, which indicates that the two switches occurred before the load registers were serviced.

13 Gi_DMA_Readbank

When implementing the PIO for read DMA, the Gi_DMA_Readbank bit indicates which save register contains the next data to be transferred. This bit alternates with each read.

0—HW save 1—SW save

Gi Input Select Register

Address Offsets: 0x048 (G0), 0x04A (G1), 0x148 (G2), 0x14A (G3)

Type: Write **Size:** 16-bit

Bit Map:

15	14	13	12	11	10	9	8
Gi_Source_ Polarity	Gi_Output_ Polarity	Gi_OR_ Gate	Gi_Gate_ Select_Load_ Source	Gi_Gate_ Select_4	Gi_Gate_ Select_3	Gi_Gate_ Select_2	Gi_Gate_ Select_1

7	6	5	4	3	2	1	0
Gi_Gate_ Select_0	Gi_Source_ Select_4	Gi_Source_ Select_3	Gi_Source_ Select_2	Gi_Source_ Select_1	Gi_Source_ Select_0	0	0

Bits	Name	Description
15	Gi_Source_Pola	rity Set this bit to invert the selected source signal, changing the polarity of the active edge.
14	Gi_Output_Pola	rity Set this bit to invert the counter output signal.
13	Gi_OR_Gate	Set this bit to OR the output of the adjacent counter with the selected gate. When the counter is not counting, only the adjacent counter output is the gate. Clearing this bit removes the effect on the gate.
12	Gi_Gate_Select_	Load_Source When this bit is set, the selected gate signal chooses the load source for the counter. An active gate level chooses Load A, while an inactive level chooses Load B. The Gi_Gating_Mode bit, located on the Gi Mode Register, must be set to Level mode.
11–7	Gi_Gate_Select_	_<40> This bit selects the signal to serve as the gate for the

This bit selects the signal to serve as the gate for the counter.

- 0—Source Pin *i*; the source pin dedicated to this counter
- 1—Gate Pin i; the gate pin dedicated to this counter
- 2—Gate Pin 0, I/O Pin 38
- 3—Gate Pin 1, I/O Pin 34
- 4—Gate Pin 2, I/O Pin 30
- 5—Gate Pin 3, I/O Pin 26
- 6—Gate Pin 4, I/O Pin 22
- 7—Gate Pin 5, I/O Pin 18
- 8—Gate Pin 6, I/O Pin 14
- 9—Gate Pin 7, I/O Pin 10
- 10—Next SRC; the selected source of the adjacent counter
- 11—RTSI 0
- 12—RTSI 1
- 13-RTSI 2
- 14—RTSI 3
- 15—RTSI 4
- 16—RTSI 5
- 17—RTSI 6
- 20—Next Out; the counter of the adjacent counter
- 30—Logic low
- 31—Logic low

6–2 Gi_Source_Select_<4..0>

This bit selects the signal the counter uses as the source.

- 0—Timebase 1; the internal timebase (20 MHz)
- 1—Source Pin *i*; the source pin dedicated to this counter
- 2—Source Pin 0, I/O Pin 39
- 3—Source Pin 1, I/O Pin 35
- 4—Source Pin 2, I/O Pin 31
- 5—Source Pin 3, I/O Pin 27
- 6—Source Pin 4, I/O Pin 23
- 7—Source Pin 5, I/O Pin 19
- 8—Source Pin 6, I/O Pin 15
- 9—Source Pin 7, I/O Pin 11
- 10—Next Gate; the selected gate of the adjacent counter
- 11—RTSI 0
- 12—RTSI 1
- 13—RTSI 2
- 14—RTSI 3
- 15—RTSI 4
- 16—RTSI 5
- 17—RTSI 6
- 18—Timebase 2; the internal timebase (100 KHz)

19—Next TC; the adjacent counter's terminal count 30—Timebase 3; the internal timebase (the maximum frequency) 31—Logic low

GO Interrupt Acknowledge Register, G2 Interrupt Acknowledge Register

Address Offsets: 0x004 (G0), 0x104 (G2)

Type: Write Size: 16-bit

Bit Map:

15	14	13	12	11	10	9	8
0	Gi_TC_ Interrupt_ Ack	0	0	0	0	0	0

7	6	5	4	3	2	1	0
0	Gi_TC_ Error_ Confirm	0	0	0	0	0	0

Bits Name Description

14 Gi_TC_Interrupt_Ack

Write a 1 to Gi_TC_Interrupt_Ack to clear the Gi Status Register Gi_TC_Status bit, and the TC status interrupt, if it was enabled in the G0 Interrupt Enable Register, G2 Interrupt Enable Register or the G1 Interrupt Enable Register, G3 Interrupt Enable Register. This bit returns to 0, immediately after the write.

6 Gi_TC_Error_Confirm

Write a 1 to Gi_TC_Error_Confirm to clear the TC error condition associated with the *G01 Status Register*, *G23 Status Register* Gi_TC_Error bit. This bit returns to 0 immediately after the write.

G1 Interrupt Acknowledge Register, G3 Interrupt Acknowledge Register

Address Offsets: 0x006 (G1), 0x106 (G3)

Type: Write Size: 16-bit

Bit Map:

15	14	13	12	11	10	9	8
0	Gi_TC_ Interrupt_ Ack	0	0	0	0	0	0

7	6	5	4	3	2	1	0
0		0	0	0	Gi_TC_ Error_ Confirm	0	0

Bits Name Description

14 Gi_TC_Interrupt_Ack

Write a 1 to Gi_TC_Interrupt_Ack to clear the Gi Status Register Gi_TC_Status bit, and the TC status interrupt, if it was enabled in the G0 Interrupt Enable Register, G2 Interrupt Enable Register or the G1 Interrupt Enable Register, G3 Interrupt Enable Register. This bit returns to 0, immediately after the write.

6 Gi_TC_Error_Confirm

Write a 1 to Gi_TC_Error_Confirm to clear the TC error condition associated with the *G01 Status Register*, *G23 Status Register* Gi_TC_Error bit. This bit returns to 0 immediately after the write.

Gi Load A Register

Ado	Address Offsets:		(G0), 0x040	(G1), 0x13	8 (G2), 0x14	0 (G3)	
Typ	oe:	Write					
Size	Size:						
Bit	Map:						
31	30	29	28	27	26	25	24
Load_A.31	Load_A.30	Load_A.29	Load_A.28	Load_A.27	Load_A.26	Load_A.25	Load_A.24
23	22	21	20	19	18	17	16
Load_A.23	Load_A.22	Load_A.21	Load_A.20	Load_A.19	Load_A.18	Load_A.17	Load_A.16
15	14	13	12	11	10	9	8
Load_A.15	Load_A.14	Load_A.13	Load_A.12	Load_A.11	Load_A.10	Load_A.9	Load_A.8
7	6	5	4	3	2	1	0
Load_A.7	Load_A.6	Load_A.5	Load_A.4	Load_A.3	Load_A.2	Load_A.1	Load_A.0

Bits Name Description

Load_A.<31..0> The Load A field is for loading the counter with Gi_Load, located on the Gi Command Register, or for reloading on gate or TC conditions. This field can alternate with Load B by using the Gi_Reload_Source_Switching bit, located on the Gi Mode Register. The A and B registers are actually two banks of load registers, X and Y, which are controlled by the bank switching attributes in the Gi Command Register.

Gi Load B Register

Load_B.7

Load_B.6

Address Offsets: Type:			0x03C (G0), 0x044 (G1), 0x13C (G2), 0x144 (G3) Write						
Size:		32-bit							
Bit	Map:								
31	30	29	28	27	26	25	24		
Load_B.31	Load_B.30	Load_B.29	Load_B.28	Load_B.27	Load_B.26	Load_B.25	Load_B.24		
23	22	21	20	19	18	17	16		
Load_B.23	Load_B.22	Load_B.21	Load_B.20	Load_B.19	Load_B.18	Load_B.17	Load_B.16		
15	14	13	12	11	10	9	8		
Load_B.15	Load_B.14	Load_B.13	Load_B.12	Load_B.11	Load_B.10	Load_B.9	Load_B.8		
7			-	2	2	1	-		
7	6	5	4	3	2	1	0		

Bits Name Description

Load_B.5

Load_B.4

31–0 Load_B.<31..0> The Load B field is for loading the counter with Gi_Load, located on the Gi Command Register, or for reloading on gate or TC conditions. It can alternate with Load B by using the Gi_Reload_Source_Switching bit in the Gi Mode Register. The A and B registers are actually two banks of load registers, X and Y, which are controlled by the bank switching attributes in the Gi Command Register.

Load_B.3

Load_B.2

Load_B.1

Load_B.0

Gi Mode Register

Address Offsets: 0x034 (G0), 0x036 (G1), 0x134 (G2), 0x136 (G3)

Type: Write Size: 16-bit

Bit Map:

15	14	13	12	11	10	9	8
Gi_Reload_ Source_ Switching	Gi_Loading on_Gate	Gi_Gate_ Polarity	Gi_Loading_ on_TC	Gi_Counting _Once_1	Gi_Counting _Once_0	Gi_Output_ Mode_1	Gi_Output_ Mode_0

7	6	5	4	3	2	1	0
Gi_Load_ Source_ Select	Gi_Stop_ Mode_1	Gi_Stop_ Mode_0	Gi_Trigger_ Mode_for Edge_ Gate_1	Gi_Trigger_ Mode_for_ Edge_ Gate_0	Gi_Gate_ on_Both_ Edges	Gi_Gating_ Mode	Gi_Gating_ Mode

Bits Name Description

15 Gi_Reload_Source_Switching

When Gi_Gate_Select_Load_Source, located on the Gi Input Select Register, is 0, the Gi_Reload_Source_Switching bit determines if the reloading always comes from the same load register (0), or if it alternates between the two (1).

14 Gi_Loading_on_Gate

When this bit is set, the gate edge reloads the counter on the next source edge. Set the Gi_Trigger_Mode_for_Edge_Gate to 3 to reload the counter on each selected edge. Otherwise, the counter reloads on the gate that stops the counter. You also can use Gi_Loading_on_Gate with Gi_Loading_on_TC.

13 Gi Gate Polarity

Setting the bit inverts the gate signal, making it active low rather than the normal active high.

12 Gi_Loading_on_TC

Loading on Terminal Count. If this bit is clear, the counter rolls over when it reaches TC. When set, the counter reloads from a Load register on TC. You also can use Gi_Loading_on_TC with Gi_Loading_on_Gate.

11, 10 G*i*_Counting_Once_<1..0>

This field determines whether the counter disarms when the counter stops for a hardware condition.

- 0-No hardware disarm
- 1—Disarm at the TC that stops counting
- 2—Disarm at the gate that stops counting
- 3—Disarm at the first TC or gate that stops counting

9, 8 Gi Output Mode <1..0>

Gi Output Mode determines the counter output type.

- 0—Reserved
- 1—The counter TC is the output; it asserts for one clock at TC
- 2—Output toggles value on each TC
- 3—Output toggles on TC or gate

7 Gi_Load_Source_Select

When the counter is disarmed, this bit determines which load register—Load A (0) or Load B (1)—loads the counter in response to a Gi_Load. Once the counter is armed, the Gi_Reload_Source_Switching bit determines the load source. After the counter is armed, writing this bit has no effect.

6, 5 $Gi_Stop_Mode_<1..0>$

This bit determines the mode in which the hardware stops the counter.

- 0—Stop on gate condition
- 1—Stop on gate or first TC
- 2—Stop on gate or second TC
- 3—Reserved



Note To make these conditions TC only, use Gi_Trigger_Mode_for_Edge_Gate to turn off the edge gate stopping.

4, 3 Gi_Trigger_Mode_for_Edge_Gate_<1..0>

This field determines how a gate edge affects the counting when gating is enabled.

- 0—The first gate edge starts, and the next gate edge stops the counting.
- 1—The first gate edge stops, and the second gate edge starts the counting.
- 2—The gate edge that always starts the counting.

TC normally stops this mode.

3—The gate not used for starting or stopping. This gate may still save, reload, or load select. Selections 0 and 1 are valid when Gi_{sol} Mode is 0, and selection 0 through 2 are only valid for edge gating and level gating.

2 Gi_Gate_on_Both_Edges

When Gi_Gate_on_Both_Edges is set and Gi_Gating_Mode is set to rising mode, the edge gating modes operate on both the rising and falling edges.

1, 0 Gi_Gating_Mode

This field determines how the gate signal is interpreted for gating operations.

- 0—Gating disabled
- 1—Level gating
- 2—Rising edge gating
- 3—Falling edge gating



Note Gi_Gate_Polarity can change the edge for modes 2 and 3. When gating is disabled, you can use the gate for counting direction only.

Address Offsets: 0x0B4 (G0), 0x0B6 (G1), 0x1B4 (G2), 0x1B6 (G3)

Chapter 3

Type: Write **Size:** 16-bit

Bit Map:

15	14	13	12	11	10	9	8
0	0	Gi_Second_ Gate_ Polarity	0	Gi_Second_ Gate_ Select_4	Gi_Second_ Gate_ Select_3	Gi_Second_ Gate_ Select_2	Gi_Second_ Gate_ Select_1

7	6	5	4	3	2	1	0
Gi_Second_ Gate_ Select_0	0	0	0	0	0	0	Gi_Second_ Gate_ Mode

Bits	Name	Description
------	------	-------------

Gi_Second_Gate_Polarity

Setting this bit inverts the selected second gate, changing the polarity.

11–7 Gi_Second_Gate_Select_<4..0>

This field selects the signal used as the second gate for the counter.

0—Source Pin i; the source pin dedicated to this counter

1—Up/Down Pin i; the Up/Down pin dedicated to this counter

2—Up/Down Pin 0, I/O Pin 37

3—Up/Down Pin 1, I/O Pin 33

4—Up/Down Pin 2, I/O Pin 29

5—Up/Down Pin 3, I/O Pin 25

6—Up/Down Pin 4, I/O Pin 21

7—Up/Down Pin 5, I/O Pin 17

8—Up/Down Pin 6, I/O Pin 13

9—Up/Down Pin 7, I/O Pin 9

10—Next SRC; the selected source of the adjacent counter

11—RTSI 0

12—RTSI 1

13—RTSI 2

14—RTSI 3

15—RTSI 4

16—RTSI 5

17-RTSI 6

20—Next Out; the adjacent counter's output

30—Selected gate; the output of the gate selection, and not the selected gate I/O pin. For example, if the gate is set to (1) Gate Pin *i* and if G*i*_Output_Polarity bit, located on the Gi Input Select Register, is set, the alternate gate is an inverted Gate Pin *i* signal. This gate is useful for pulse measurement.

31—Logic low

0 Gi_Second_Gate_Mode

The second gate feature allows one signal to start the counter and another to stop it for two-edge separation measurements. When set, Gi_Second_Gate_Mode modifies the actual gate signal with a combination of the first and second gate. An assertion of the second gate signals asserts the counter gate, and an assertion of the gate signal deasserts the gate. You can then use this new gate signal for start and stop operations.

Gi_Second_Gate_Mode is also useful in pulse-width measurements. The level gating mode starts counting if the counter is armed while the gate is high, so the first measurement may be too short. Using the selected gate input to the second gate and inverting both gate and second gate polarity forces a rising edge to occur before the gate asserts. As a result, the first pulse is measured.

Gi_Second_Gate_Mode is also used for two-edge separation measurements.

Gi Status Register

Address Offsets: 0x004 (G0), 0x006 (G1), 0x104 (G2), 0x106 (G3)

Type: Read Size: 16-bit

Bit Map:

15	14	13	12	11	10	9	8
Gi_Interrupt	X	X	X	X	X	X	X

7	6	5	4	3	2	1	0
X	X	X	X	Gi_TC_ Status	X	X	X

Bits	Name	Description
15	Gi_Interrupt	This counter asserts an interrupt. TC or DMA Interrupt is true and enabled.
3	Gi_TC_Status	Terminal Count Status. This bit indicates that the counter has reached terminal count. Setting Gi_TC_Interrupt_Ack, located on the G0 Interrupt Acknowledge Register, G2 Interrupt Acknowledge Register and the G1 Interrupt Acknowledge Register, G3 Interrupt Acknowledge Register, clears this bit. Gi_TC_Status is useful for generating interrupts at a constant frequency.

Gi SW Save Register

Ado	dress Offsets	s: 0x018	(G0), 0x010	C (G1), 0x11	8 (G2), 0x11	IC (G3)	
Typ	oe:	Read					
Size	e :	32-bit					
Bit	Map:						
31	30	29	28	27	26	25	24
SW_ Save.31	SW_ Save.30	SW_ Save.29	SW_ Save.28	SW_ Save.27	SW_ Save.26	SW_ Save.25	SW_ Save.24
23	22	21	20	19	18	17	16
SW_ Save.23	SW_ Save.22	SW_ Save.21	SW_ Save.20	SW_ Save.19	SW_ Save.18	SW_ Save.17	SW_ Save.16
15	14	13	12	11	10	9	8
SW_ Save.15	SW_ Save.14	SW_ Save.13	SW_ Save.12	SW_ Save.11	SW_ Save.10	SW_Save.9	SW_Save.8
7	6	5	4	3	2	1	0
SW_Save.7	SW_Save.6	SW_Save.5	SW_Save.4	SW_Save.3	SW_Save.2	SW_Save.1	SW_Save.0

Bits Name Description

31-0 SW_Save_<31..0>

Software Save. This value is latched on the next source edge following the assertion of the Gi_Save_Trace bit, located on the $Gi_Command\ Register$. When the bit is clear, the counter value is transparent through the $Global\ Interrupt\ Status\ Register$.

This register is also part of the buffer for DMA operations. When Gi DMA Enable, located on the Gi DMA Config Register is set, the Gi SW Save Register is used as a Gi HW Save Register. In DMA mode, the save value alternates between the Gi HW Save Register and the Gi SW Save Register.

Global Interrupt Config Register

Ado	dress Offset:	0x770					
Typ	e:	Write					
Size	e:	32-bit					
Bit	Map:						
31	30	29	28	27	26	25	24
Global_Int_ Enable	Global_Int_ Polarity	Cascade_ Int_Enable	0	0	0	0	0
23	22	21	20	19	18	17	16
0	0	0	0	0	0	0	0
15	14	13	12	11	10	9	8
0	0	0	0	0	0	0	0
7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0

Chapter 3

Bit	Name	Description
31	Global_Int_Ena	Global Interrupt Enable. Clearing this bit disables the assertion of the INT pin. When set, it allows the INT pin to assert when a condition is true.
30	Global_Int_Pol	arity Global Interrupt Polarity. Setting this bit flips the polarity of the INT pin, causing it to go low on an interrupt assertion.
29	Cascade_Int_E	Cascade Interrupt Enable. Setting this bit allows the CAS INT pin to be routed to the INT pin in combination with the other sources. Clearing the bit prevents any

cascade interrupts. On devices with two NI-TIO ASICS, such as the NI 6602, the CAS_INT pin is connected to the second NI-TIO.

Global Interrupt Status Register

Ado	dress Offset	20x754					
Typ	pe:	Read					
Size	e:	32-bit					
Bit	Map:						
31	30	29	28	27	26	25	24
Global_Int	X	Cascade_ Int	X	X	X	X	X
23	22	21	20	19	18	17	16
X	X	X	X	Counter_3_ Int	Counter_2_ Int	Counter_1_ Int	Counter_0_ Int
15	14	13	12	11	10	9	8

Chapter 3

7	6	5	4	3	2	1	0
X	X	X	X	X	X	X	X

X

X

Bits	Name	Description
31	Global_Int	Global Interrupt. This bit is set when the NI-TIO is generating an interrupt.
29	Cascade_Int	Cascade Interrupt. This bit reflects the state of the CAS_INT pin. On devices with two NI-TIO ASICS, such as the NI 6602, the CAS_INT pin is connected to the second NI-TIO.

19–16 Counter_<3..0>_Int

Counter Interrupts. These bits are set when the counter is generating an interrupt. Refer to the appropriate counter register—*Gi Status Register* or *Gi DMA Status Register*—for more information.

X

X

X

X

X

X

Reset Control Register

Ty _j Siz		0x700 Write 32-bit					
31	30	29	28	27	26	25	24
0	0	0	0				
23	22	21	20	19	18	17	16
15	14	13	12	11	10	9	8
7	6	5	4	3	2	1	0
							Soft_Reset

Bit	Name	Description
0	Soft_Reset	Writing a 1 to this bit resets the chip. This bit clears automatically.

Simple Digital I/O

An 8-bit DIO port is available for simple unstrobed read and write operations.

STC Digital I/O

The 8-bit digital port provides individual control over the direction and state of each bit. This port is located on pins 0 through 7.

STC Digital I/O Registers

Table 3-2 shows the STC digital I/O register map. The table provides the register name, the register address offset from the device base address (BAR1), the type of register—read-only and write-only, and the size of the register in bits.

Registers are grouped in the table by offset, and the register descriptions following the table are organized alphabetically.

Register Name	Offset (Hex)	Туре	Size
STC DIO Parallel Input	0x00E	Read-only	16-bit
STC DIO Output	0x014	Write-only	16-bit
STC DIO Control	0x016	Write-only	16-bit
STC DIO Serial Input	0x038	Read-only	16-bit

Table 3-2. STC Digital I/O Register Address Map

STC DIO Control

Address Offset: Type: Size: Bit Map:		0x016 Write 16-bit					
15	14	13	12	11	10	9	8
0	0	0	0	Serial_SW_ Strobe	Serial_ Timebase	Serial_HW_ Enable	Serial_Start
7	6	5	4	3	2	1	0
OE_7	OE_6	OE_5	OE_4	OE_3	OE_2	OE_1	OE_0

Bits	Name	Description
11	Serial_SW_Strobe	Serial Software Strobe. When the Serial_HW_Enable bit is disabled, the Serial_SW_Strobe bit can toggle the serial clock.
10	Serial_Timebase	0—Serial clock is Timebase 1 / 24 (1.2 μs) 1—Serial clock is Timebase 2 (100 KHz)
9	Serial_HW_Enable	Serial Hardware Enable. Setting this bit enables hardware parallel-to-serial conversion. Setting this bit causes serial clock to be driven on STC DOUT 4 and serial data out to be driven on STC DOUT 0.
8	Serial_Start	Setting this bit initiates parallel-to-serial conversion of the STC DIO Output Register, starting with bit 0. It also captures serial input into the serial input register. This bit automatically clears when the conversion completes. The Serial_In_Progress bit, located on the <i>G01 Joint Status 1 Register</i> , can monitor the conversion progress.
7–0	OE_<70>	Output Enable. These bits control the output enable for the STC DIO lines when using I/O pins 7 through 0 if these pins are programmed as inputs in the I/O configuration registers. This setting makes the port

compatible with the DAQ-STC. The I/O configuration registers also control the output enables, in which case these bits are ignored.

STC DIO Output

Address Offset:0x014Type:WriteSize:16-bit

Bit Map:

15	14	13	12	11	10	9	8
Serial_							
DOUT.7	DOUT.6	DOUT.5	DOUT.4	DOUT.3	DOUT.2	DOUT.1	DOUT.0

7	6	5	4	3	2	1	0
Parallel_							
DOUT.7	DOUT.6	DOUT.5	DOUT.4	DOUT.3	DOUT.2	DOUT.1	DOUT.0

Bits	Name	Description
15–8	Serial_DOUT.<	70> Serial Digital Output. This field loads the output register to be shifted on the next serial start.
7–0	Parallel_DOUT	.<70> Parallel Digital Output. This field immediately updates the STC DOUT pins when they are enabled for output drive.

STC DIO Parallel Input

Ad	dress Offset:	0x00E					
Type:		Read					
Siz	e:	16-bit					
Bit	Map:						
15	14	13	12	11	10	9	8
X	X	X	X	X	X	X	X

7	6	5	4	3	2	1	0
DIN.7	DIN.6	DIN.5	DIN.4	DIN.3	DIN.2	DIN.1	DIN.0

Bits	Name	Description
7–0	DIN.<70>	Digital Input. This field reads the state of the DAQ-STC DIO pins.

STC DIO Serial Input

Address Offset: Type: Size: Bit Map:		0x038 Read 16-bit					
15	14	13	12	11	10	9	8
X	X	X	X	X	X	X	X
7	6	5	4	3	2	1	0
Serial_ DIN.7	Serial_ DIN.6	Serial_ DIN.5	Serial_ DIN.4	Serial_ DIN.3	Serial_ DIN.2	Serial_ DIN.1	Serial_ DIN.0

Bits Name Description

7–0 Serial_DIN.<7..0>

Serial Digital Input. These bits store the serial input data after hardware serial-to-parallel conversion completes.

I/O Connection Registers

The NI-TIO has a 40-pin I/O connector interface. These 40 bidirectional signals control most of the NI-TIO operations. The direction and output signals are programmable.



Note When the NI-TIO powers up, all I/O pins are in the common-input usage state.

Pin Usage

Table 3-3 lists output sources and common inputs for each I/O connection pin.

Table 3-3. I/O Connection Pin Usage

Pin Number	Common Input Usage	Counter Output
PFI 0	STC DIN 0	STC DOUT 0
PFI 1	STC DIN 1	STC DOUT 1
PFI 2	STC DIN 2	STC DOUT 2
PFI 3	STC DIN 3	STC DOUT 3
PFI 4	STC DIN 4	STC DOUT 4
PFI 5	STC DIN 5	STC DOUT 5
PFI 6	STC DIN 6	STC DOUT 6
PFI 7	STC DIN 7	STC DOUT 7
PFI 8	_	Counter 7 Output
PFI 9	Up/Down 7	_
PFI 10	Gate 7	Counter 7 Selected Gate
PFI 11	Source 7	Counter 7 Selected Source
PFI 12	_	Counter 6 Output
PFI 13	Up/Down 6	_
PFI 14	Gate 6	Counter 6 Selected Gate
PFI 15	Source 6	Counter 6 Selected Source
PFI 16	_	Counter 5 Output

Table 3-3. I/O Connection Pin Usage (Continued)

Pin Number	Common Input Usage	Counter Output
PFI 17	Up/Down 5	_
PFI 18	Gate 5	Counter 5 Selected Gate
PFI 19	Source 5	Counter 5 Selected Src
PFI 20	_	Counter 4 Output
PFI 21	Up/Down 4	_
PFI 22	Gate 4	Counter 4 Selected Gate
PFI 23	Source 4	Counter 4 Selected Source
PFI 24	_	Counter 3 Output
PFI 25	Up/Down 3	_
PFI 26	Gate 3	Counter 3 Selected Gate
PFI 27	Source 3	Counter 3 Selected Source
PFI 28	_	Counter 2 Output
PFI 29	Up/Down 2	_
PFI 30	Gate 2	Counter 2 Selected Gate
PFI 31	Source 2	Counter 2 Selected Source
PFI 32	_	Counter 1 Output
PFI 33	Up/Down 1	_
PFI 34	Gate 1	Counter 1 Selected Gate
PFI 35	Source 1	Counter 1 Selected Source
PFI 36	_	Counter 0 Output
PFI 37	Up/Down 0	_
PFI 38	Gate 0	Counter 0 Selected Gate
PFI 39	Source 0	Counter 0 Selected Source

I/O Registers

Table 3-4. I/O Connection Register Address Map

Register Name	Offset (Hex)	Type	Size
I/O Config Reg 0–1	0x77C	Read and Write	16-bit
I/O Config Reg 2–3	0x77E	Read and Write	16-bit
I/O Config Reg 4–5	0x780	Read and Write	16-bit
I/O Config Reg 6–7	0x782	Read and Write	16-bit
I/O Config Reg 8–9	0x784	Read and Write	16-bit
I/O Config Reg 10–11	0x786	Read and Write	16-bit
I/O Config Reg 12–13	0x788	Read and Write	16-bit
I/O Config Reg 14–15	0x78A	Read and Write	16-bit
I/O Config Reg 16–17	0x78C	Read and Write	16-bit
I/O Config Reg 18–19	0x78E	Read and Write	16-bit
I/O Config Reg 20–21	0x790	Read and Write	16-bit
I/O Config Reg 22–23	0x792	Read and Write	16-bit
I/O Config Reg 24–25	0x794	Read and Write	16-bit
I/O Config Reg 26–27	0x796	Read and Write	16-bit
I/O Config Reg 28–29	0x798	Read and Write	16-bit
I/O Config Reg 30–31	0x79A	Read and Write	16-bit
I/O Config Reg 32–33	0x79C	Read and Write	16-bit
I/O Config Reg 34–35	0x79E	Read and Write	16-bit
I/O Config Reg 36–37	0x7A0	Read and Write	16-bit

I/O Config Register, Pins A through B

Address Offset: 0x77C, 0x77E, 0x780, 0x782, 0x784, 0x786, 0x788, 0x78A,

0x78C, 0x78E, 0x790, 0x792, 0x794, 0x79A, 0x79C, 0x79E,

0x7A0

Type: Read and Write

Size: 16-bit

Bit Map:

15	14	13	12	11	10	9	8
X	A_Input_ Select_2	A_Input_ Select_1	A_Input_ Select_0	X	X	A_Output_ Select_1	A_Output_ Select_0
7	6	5	4	3	2	1	0
X	B_Input_ Select_2	B_Input_ Select_1	B_Input_ Select_0	X	X	B_Output_ Select_1	B_Output_ Select_0

Bits	Name	Description
9, 8	A_Output_S	Select_<10>
1, 0	B Output S	Select_<10>

This field determines if the I/O pin is driven and what signal is driven into the pin.

0—Pin is input only; driver goes to a high-impedance state

1—Normal counter output

14–12 A_Input_Select_<2..0> 6–4 B_Input_Select_<2..0>

This field allows each input pin to be passed through or digitally filtered to remove noise. The digital filters sample the signal using Timebase 3, and upon detecting a state change, require it to be in the same state for a minimum pulse width either internally generated or selected from a RTSI line.

- 0—Input signal unchanged
- 1—Input synchronized to Timebase 3
- 2—Digital filter; minimum pulse width is 100 assertions of Timebase 1
- 3—Digital filter; minimum pulse width is 20 assertions of Timebase 1
- 4—Digital filter; minimum pulse width is 10 assertions of Timebase 1

5—Digital filter; minimum pulse width is 2 assertions of Timebase 1

6—Digital filter; minimum pulse width is 2 assertions of Timebase 3

MITE

The MITE is located on PCI BAR0, offset 0x0.

To enable the BAR1 address space where the NI-TIO ASICs are located, write to the I/O Window Base Size Register 1 (IODWBSR1) on the MITE. The IODWBSR1 determines the location and size of the I/O window in the CPU address space. This window is used to access the device address space on the I/O port.

For example, if the PCI/PXI device base address range 0 is BAR0, and the card base address range 1 is BAR1, enable BAR1 with the following function calls:

```
Bar0.write32(0xC4, (physicalBAR1 & 0xFFFFFF00L) | 0x8C);
Bar0.write32(0xF4, 0);
```

I/O Window Base Size Register 1 (IOWBSR1)

Ty _I Size			and Write				
31	30	29	28	27	26	25	24
BA31	BA30	BA29	BA28	BA27	BA26	BA25	BA24
23	22	21	20	19	18	17	16
BA23	BA22	BA21	BA20	BA19	BA18	BA17	BA16
15	14	13	12	11	10	9	8
BA15	BA14	BA13	BA12	BA11	BA10	BA9	BA8
7	6	5	4	3	2	1	0
WENAB	X	X	WSIZE4	WSIZE3	WSIZE2	WSIZE1	WSIZE0

Bits	Name	Description
31–12	BA_<318>	Base Address. These bits indicate the base address of the 8 KB device window in CPU address space. The number of bits compared is determined by the GSIZE and WSIZE bits.
7	WENAB	Window Enable. Setting this bit enables the window. Clearing this bit disables the window.
6–5	X	X should always be written with a 0, and ignored when read.
0	WSIZE	Window Size. The WSIZE bits determine the number of address bits to compare. The minimum window size is 256 bytes. The size in bytes is equal to $2^{(WSIZE + 1)}$ for WSIZE > 7.

I/O Window Control Register 1 (IOWCR1)

Tyj Siz			and Write				
31	30	29	28	27	26	25	24
X	X	X	X	X	X	X	X
23	22	21	20	19	18	17	16
X	X	X	X	X	X	X	X
15	14	13	12	11	10	9	8
X	X	X	X	X	X	X	X
7	6	5	4	3	2	1	0
X	X	X	X	X	X	X	X

Bits	Name	Description
31-0	X	These bits should always be written to with a 0 and will
		always read back as an X.



Technical Support and Professional Services

Visit the following sections of the National Instruments Web site at ni.com for technical support and professional services:

- **Support**—Online technical support resources include the following:
 - Self-Help Resources—For immediate answers and solutions, visit our extensive library of technical support resources available in English, Japanese, and Spanish at ni.com/support. These resources are available for most products at no cost to registered users and include software drivers and updates, a KnowledgeBase, product manuals, step-by-step troubleshooting wizards, hardware schematics and conformity documentation, example code, tutorials and application notes, instrument drivers, discussion forums, a measurement glossary, and so on.
 - Assisted Support Options—Contact NI engineers and other measurement and automation professionals by visiting ni.com/ask. Our online system helps you define your question and connects you to the experts by phone, discussion forum, or email.
- Training—Visit ni.com/custed for self-paced tutorials, videos, and interactive CDs. You also can register for instructor-led, hands-on courses at locations around the world.
- **System Integration**—If you have time constraints, limited in-house technical resources, or other project challenges, NI Alliance Program members can help. To learn more, call your local NI office or visit ni.com/alliance.

If you searched ni.com and could not find the answers you need, contact your local office or NI corporate headquarters. Phone numbers for our worldwide offices are listed at the front of this manual. You also can visit the Worldwide Offices section of ni.com/niglobal to access the branch office Web sites, which provide up-to-date contact information, support phone numbers, email addresses, and current events.

Glossary

Prefix	Meaning	Value
μ-	micro-	10-6
k-	kilo-	10^{3}
M-	mega-	106
G-	giga-	109

Symbols

negative of, or minus

/ per

% percent

± plus or minus

+ positive of, or plus

A

arm to enable a counter to start an operation. If the application requires a trigger,

an armed counter waits for the trigger to begin the operation.

ASIC application specific integrated circuit

asynchronous a property of an event that occurs at an arbitrary time, without

synchronization to a reference clock

AUX_LINE the second gate input for the general-purpose counter/timers on the

NI-TIO. This input doubles as an up/down control input.

В

b bit—one binary digit, either 0 or 1

B byte—eight related bits of data, an eight-bit binary number. Also used to

denote the amount of memory required to store one byte of data.

BAR base address memory—a memory address that serves as the starting

address for programmable registers. All other addresses are located by

adding to the base address.

BCD binary-coded decimal—a method of encoding numbers where each

decimal digit is encoded separately

buffer a block of memory used to store measurement results

buffered a type of measurement in which multiple measurements are made

consecutively and measurement results are stored in a buffer

bus the group of conductors that interconnect individual circuitry in a computer.

Typically, a bus is the expansion vehicle to which I/O or other devices are

connected. Examples of PC buses are the AT, EISA, and PCI bus.

C

CAS INT cascade interrupt

clock hardware component that provides timing for various device operations

CMOS complementary metal-oxide semiconductor

CompactPCI an electrical superset of the PCI bus architecture with a mechanical form

factor suited for industrial applications

counter/timer a circuit that counts external pulses or clock pulses (timing)

CPU central processing unit—the computational and control unit of a computer

that interprets and executes instructions

D

DACK DMA controller

DAQ data acquisition—(1) collecting and measuring electrical signals from

sensors, transducers, and test probes or fixtures and inputting them to a computer for processing; (2) collecting and measuring the same kinds of electrical signals with A/D and/or DIO boards plugged into a computer, and possibly generating control signals with D/A and/or DIO boards in the

same computer

DAQ-STC Data Acquisition System Timing Controller Chip

decode used in the context of motion encoders. The two channels of a motion

encoder indicate information about movement and direction of movement of an external device. Decoding refers to extracting this information from

the signals on these channels.

device a plug-in data acquisition board, card, or pad that can contain multiple

channels and conversion devices. Plug-in boards, PCMCIA cards, and DAQ devices that connect to your computer parallel port, are all examples

of DAQ devices.

DIN Digital Input

DIO Digital Input/Output

DMA Direct Memory Access—a method by which data can be transferred

to/from computer memory from/to a device or memory on the bus while the processor does something else. DMA is the fastest method of transferring

data to/from computer memory.

driver software that controls a specific hardware device such as a DAQ device

DRQ DMA Request

duty cycle the percentage of the cycle in which the pulse is high

E

EEPROM Electrically Erasable Programmable Read-Only Memory—ROM that can

be erased with an electrical signal and reprogrammed

EISA Extended Industry Standard Architecture

encode used in the context of motion encoders. Motion encoders provide

information about movement and direction of movement of an external device. The process of producing the pulses that contain this information is

called encoding.

F

FIFO First-In-First-Out—a data buffering technique that functions like a shift

register where the oldest values (first in) come out first

G

G_OUT a TC-related counter output signal that can toggle on every counter TC or

directly output the counter TC signal

GATE the signal that controls the operation of a counter. This signal may start or

stop the operation of a counter, reload the counter, or save the results of a

counter.

GND ground

GPCT General-Purpose Counter/Timer

Н

hardware the physical components of a computer system, such as the circuit boards,

plug-in boards, chassis, enclosures, peripherals, cables, and so on

high-impedance a third output state, other than high or low, in which the output is undriven

HW hardware

HW Save Register a register inside the NI-TIO ASIC that stores the result of a measurement

Hz hertz—a unit of frequency. One hertz corresponds to one cycle or event per

second

ı

I/O Input/Output—the transfer of data to/from a computer system involving

communications channels, operator interface devices, and/or data

acquisition and control interfaces

interrupt a computer signal indicating that the CPU should suspend its current task

to service a designated activity

INTERRUPT a counter output interrupt signal routed to the MITE

interrupt level the relative priority at which a device can interrupt

IODWBSR I/O Device Window Base Size Register

IRQ Interrupt Request Signal

ISA Industry Standard Architecture

ISR Interrupt Service Routine

K

K denotes 1,024, or 2¹⁰, used with B (Bytes) in quantifying data or computer

memory

L

LabVIEW Laboratory Virtual Instrument Engineering Workbench—an NI graphical

programming application

M

m meters

max maximum

maximum timebase the fastest internal timebase available on a device. For the NI 6601, the

maximum timebase is 20 MHz. For the NI 6602 and NI 6608, the

maximum timebase is 80 MHz.

min minimum

MITE a custom ASIC designed by National Instruments that implements the

PCI bus interface. The MITE supports bus mastering for high speed data

transfers over the PCI bus.

motion encoders transducers that generate pulses to indicate the physical motion of a device.

The most common type of motion encoders are quadrature encoders.

Two-pulse encoders (also referred to as up/down encoders) are another

example.

MXI Multisystem eXtension Interface—a high-performance communication

link that interconnects devices using round, flexible cables

N

NI-DAQ NI driver software for DAQ hardware

NI-TIO a custom ASIC developed by National Instruments that provides counter

and digital I/O functionality

noise an undesirable electrical signal—noise comes from external sources such

as the AC power line, motors, generators, transformers, fluorescent lights, soldering irons, CRT displays, computers, electrical storms, welders, radio transmitters, and internal sources such as semiconductors, resistors, and capacitors. Noise corrupts signals you are trying to send

or receive.

0

operating system base-level software that controls a computer, runs programs, interacts with

users, and communicates with installed hardware or peripheral devices

P

PCI Peripheral Component Interconnect—a high-performance expansion bus

architecture originally developed by Intel to replace ISA and EISA. It is achieving widespread acceptance as a standard for PCs and work-stations;

it offers a theoretical maximum transfer rate of 132 Mbytes/s.

PFI Programmable Function Input

PIO Programmed I/O

port (1) a communications connection on a computer or a remote controller;

(2) a digital port, consisting of lines of digital input and/or output

prescaling the division of frequency of an input signal that is to be used as SOURCE

of a counter

programmed I/O a data transfer method in which the CPU reads or writes data as prompted

by software

PXI modular instrumentation standard based on CompactPCI developed by

National Instruments with enhancements for instrumentation

Q

quadrature encoders a motion encoder that has two channels: channels A and B. Pulses and

phases of pulses on channels A and B carry information about degree and direction of movement. A third channel—channel Z—may also exist that

provides a reference point for position.

R

reflection a high-speed signal transition behaves like a wave and is reflected like a

wave at an inadequately terminated endpoint. This phenomenon is referred

to as reflection.

RG Reserved Ground—pins that are marked RG on the I/O connector are

no-connects if you use the SH6868-D1 shielded cable, while they are

ground pins if you use the R6868 unshielded ribbon cable.

ribbon cable a flat cable in which the conductors are side by side

RMA Return Material Authorization

RTSI Bus Real-Time System Integration Bus—the NI timing bus that directly

connects DAQ devices, by means of connectors on top of the boards,

for precise synchronization of functions

S

s seconds

Selected Gate the gate input on the four general-purpose counter/timers on the NI-TIO

Selected Source the source input on the four general-purpose counter/timers on the NI-TIO

source in the counter context, source refers to the signal that causes the counter to

increment or decrement. In the context of signals, source refers to the

device that drives a signal.

SRC Source—the signal that causes the counter to increment or decrement

start trigger a TTL level signal having two discrete levels—a high and a low level—that

starts an operation

synchronous a property of an event that is synchronized to a reference clock

T

TC Terminal Count—a strobe that occurs when a counter reaches zero from

either direction

termination matching of impedances at the end of a signal path to minimize reflections

timebase another term used for the SOURCE of a counter. Usually indicates an

internal SOURCE provided by or derived from an onboard oscillator.

TIO Timing I/O

trigger any event that causes, starts, or stops some form of data capture

TTL Transistor-Transistor Logic

two-pulse encoder a motion encoder that has two channels: channels A and B. Pulses on

channel A indicate movement in one direction while pulses on channel B indicate movement in the opposite direction. This type of encoder is also

referred to as up down encoder.

U

unstrobed digital I/O a type of digital input or output in which software reads or writes the digital

line or port states directly, without using any handshaking or hardware-controlled timing functions. Also called *immediate*,

nonhandshaking, or unlatched digital I/O.

UP_DOWN the signal that determines whether a counter increments or decrements

V

VI Virtual Instrument—a LabVIEW software module which consists of a front

panel user interface and a block diagram program.

W

wire data path between nodes